## LBI-39034A

# $\begin{array}{c} \textbf{MAINTENANCE MANUAL} \\ \textbf{ORION}^{\text{TM}} \end{array}$

## **UHF POWER AMPLIFIER UNITS**

20 WATT	403-440 MHz
20 WATT	440-470 MHz
40 WATT	403-440 MHz
40 WATT	440-470 MHz
35 WATT	470-512 MHz
100 WATT	403-440 MHz
100 WATT	440-470 MHz
80 WATT	470-512 MHz
	20 WATT 40 WATT 40 WATT 35 WATT 100 WATT

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### **DESCRIPTION**

The Radio Frequency (RF) Power Amplifiers for the UHF **ORION**<sup>TM</sup> mobile radio are provided in three different frequency ranges and power levels designated as follows:

- 344A4573P1 (CAH-545EA) 403-440 MHz, 20 WATT used in low power applications 344A4573P2 (CAH-545EB) 440-470 MHz, 20 WATT used in low power applications
- 344A4573P3 (CAH-545LA) 403-440 MHz, 35/40 WATT used in mid power applications 344A4573P4 (CAH-545LB) 440-470 MHz, 35/40 WATT used in mid power applications 344A4573P5 (CAH-545LC) 470-512 MHz, 35/40 WATT used in mid power applications
- 344A4573P6 (CAH-545HA) 403-440 MHz, 80/100 WATT used in high power applications 344A4573P7 (CAH-545HB) 440-470 MHz, 80/100 WATT used in high power applications 344A4573P8 (CAH-545HC) 470-512 MHz, 80/100 WATT used in high power applications

The exciter for each of the three power amplifiers is located on Synthesizer/Receiver/Exciter board CMN-354-1. This exciter circuit provides approximately 500 milliwatt input to the PA (refer to Maintenance Manual LBI- 38905). The PA utilizes a single power amplifier module (HC1) as the driver unit. In the case of the 20 watt amplifier the power module is the only power amplifying unit (Refer to Figure 1). With the other two power levels the power module drives other power transistors to provide the power output required (Refer to Figures 2 and 3). Each power amplifier is provided with an antenna switch and limiter circuit to isolate the receive circuit from the transmit circuit, limiting the receiver input from being over driven due to large RF signals. Each power amplifier has a power detect circuit which controls an Automatic Power Control (APC) circuit to keep the power output constant. A low-pass filter is provided in the antenna circuit to reduce harmonic emissions. A keyed Tx 9V regulator is provided to power the APC cir-

#### **CIRCUIT ANALYSIS**

#### **20 WATT**

The 20 Watt PA assembly uses one power module (HC1) to provide the output power.

Supply voltage for the power amplifier is connected from power leads on the System Interface Board to J3 (A+) and G (A-) on the PA Board. Diode CD7 is a surge protector to suppress pulses on the power leads. Diode CD8 will cause the fuse to blow if the polarity of the power leads is reversed.

The Exciter output is coupled through connector J151 on the Synthesizer/Receiver/Exciter Board to input connector J1 on the PA board. The 500 milliwatt RF input at J1 is coupled to power module HC1 through an attenuator pad consisting of resistors R1-R3. This pad attenuates the power to about 300 milliwatt and provides isolation between Exciter and PA. The power module (HC1) amplifies the 300 milliwatt input to 20 Watts.

The power module consists of a three-stage RF amplifier (Refer to **IC DATA**). The first stage power supply voltage is supplied by the power control circuit. The second and third stage power supply voltage is supplied by **SMOOTHING FILTER** transistor TR1. The second and third stage RF amplifiers operate as class C.

The 20 Watts output of HC1 is coupled to the **ANTENNA** and **ANTENNA SWITCH & LIMITER** circuits through 50 ohm stripline Z1.

#### **Antenna Switch & Limiter**

The Antenna Switch circuit consists of capacitor C25 and inductor L9 and takes the place of a quarter-wave micro strip line. When **TX9V** output goes high, bias current flows through switching diodes CD3 and CD4. A low impedance now exists at the anode of CD4 and a high impedance exists at the node connection of C25 and L9. This isolates the transmitter power from the receiver. Diode CD3 is now an RF short and along with capacitor C12, couples the power to the lowpass filter and on to the antenna.

The limiter circuit consists of transistors TR7, TR8 and diode package CD13. While receiving, if the received signal level exceeds +10 dBm, the rectified currents of CD13 provide forward bias to TR7, TR8 and PIN diode CD4 proportional to the received signal level. This causes a quarter-wave circuit (lumped constants C25 and L9) to turn on when the received signal exceeds +10 dBm and protects the receiver from excessively high receive signal levels.

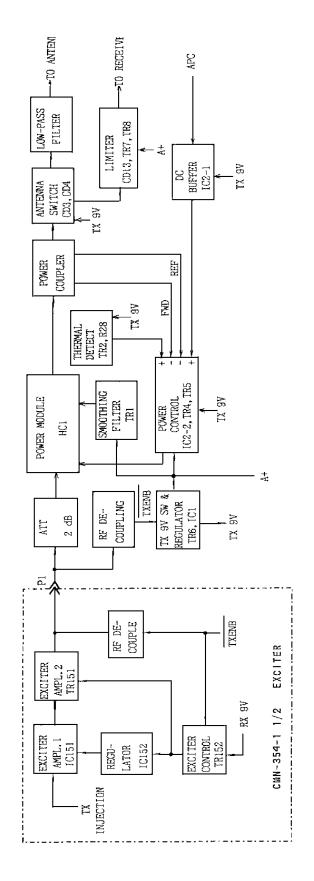


Figure 1 - 20-Watt Power Amplifier Block Diagram

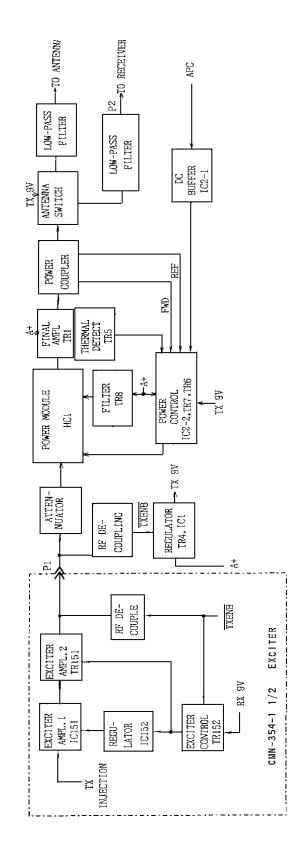


Figure 2 - 35/40-Watt Power Amplifier Block Diagram

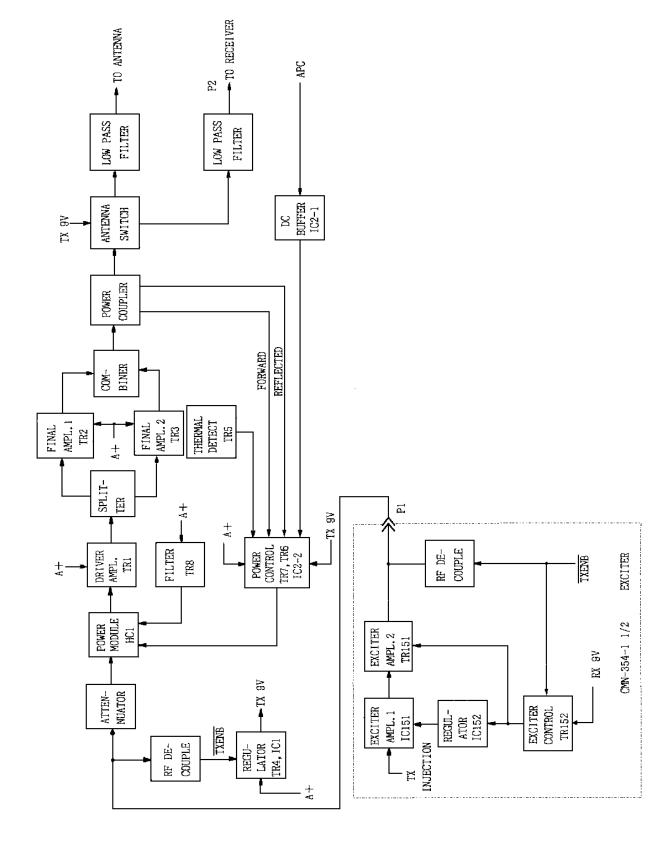


Figure 3 - 80/100 - Watt Power Amplifier Block Diagram

#### Tx 9V Switch

When the lead, located on the Synthesizer/Receiver/Exciter board, goes low, the DC voltage on J151 goes low. On the PA board, the DC voltage on J1 also goes low completing the circuit for diode CD9. With CD9 conducting TX 9V Switch transistor TR6 conducts applying A+ (13.32 V) to the input of +9 Volt Regulator IC1. The regulated +9 volts applies bias to operational amplifier IC2, transistor TR2 and switching diodes CD3 and CD4.

#### **Power Control**

The Auto Power Control (APC) circuit protects the transmitter PA from damage due to:

- a. excessive output power
- b. excessive reflected power

or

c. excessive temperature

The output power control circuit allows the RF output power to be set at rated power by the APC voltage from the Logic/IF/Audio Board. If the output power of the PA increases, the detected voltage and the input to operational amplifier IC2-2 increases. The output voltage of operational amplifier IC2-2 decreases. This causes **DC DRIVER** transistor TR5 to conduct less. This increases the base voltage on PNP **DC PASS** transistor TR4, causing it to conduct less. This results in less voltage being applied to the first amplifier stage in RF Power Module HC1, reducing the output power of the PA in proportion to the increases in output power detected by the circuit.

To protect the PA against badly mismatched loads, a reverse power detector circuit (VSWR) consisting of diode CD2, transistor TR5, operational amplifier IC2-2 and pass transistor TR4 detects reverse (reflected) power. When sufficient power is detected by CD2 to cause it to conduct, the voltage at the output of IC2-2 decreases, causing the Power Module to lower the output power, protecting the PA. The reverse power level is set by resistor R8 connected in series with diode CD2.

The PA is protected against temperature increases by a thermal detector circuit. This circuit consists of resistor R28, **THERMAL DETECT** transistor TR2, **DC DRIVER** transistor TR5 and **DC AMPL** operational amplifier IC2-2. As temperature increases, the resistance to ground through thermal detector resistor R28 increases. This causes IC2-2 to conduct less, causing a decrease in PA output until the temperature level is reduced. The temperature level is set by resistor R28. When the heatsink temperature rises above 90 C, the resistance of R28 increases and the power output is reduced.

#### 35/40 WATT

The 35/40 Watt PA assembly uses one power module (HC1) and one RF power transistor (TR1) to provide the output power.

Supply voltage for the power amplifier is connected from power leads on the System Interface Board to J3 (A+) and G (A-) on the PA Board. Diode CD2 is a surge protector to suppress pulses on the power leads. (Diode CD1001 in the PA UNIT will cause a fuse to blow if the voltage polarity is reversed. Refer to the PA INTERCONNECTION DIAGRAM)

Test Points (TP) are the printed board terminals for measuring control voltage as follows:

- TP1 A+ (13.42V)
- TP2 Control Voltage (4.72V)
- TP3 Forward Power Detect (2.64V)
- TP4 Tx 9V (9.12V)
- TP5 APC Voltage on output of DC AMPL IC2-1 (2.64V)
- TP6 Voltage to HC1, pins 3 &4 (12.5V)
- TP7 APC Voltage (3.5V)

The Exciter output is coupled through connector J151 on the Synthesizer/Receiver/Exciter Board to input Jack P1 on the PA board. The 500 milliwatt RF input at P1 is coupled to power module HC1 through an attenuator pad consisting of resistors R1-R4. This pad attenuates the 500 milliwatt to about 300 milliwatt and provides isolation between Exciter and PA. The power module (HC1) amplifies the 300 milliwatt input to 13 Watts.

The power module consists of a three-stage RF amplifier (Refer to IC DATA). The first stage power supply voltage is supplied by the power control circuit. The second and third stage power supply voltage is supplied by **SMOOTHING FILTER** transistor TR8. The second and third RF amplifiers operate as class C.

The 13 Watts output of HC1 is coupled to **POWER AMPL** transistor TR1 through impedance matching components consisting of capacitors C7, C9, C10 and inductor L2 through coupling capacitor C8. Transistor TR1 amplifies the 13 Watt level to 40 Watts. The output of TR1 is coupled to the **ANTENNA** and **ANTENNA SWITCH** through impedance matching components consisting of capacitors C11-C13, inductor L6 and impedance matching network Z2 through coupling capacitor C14 and 50 ohm stripline Z7.

#### **Antenna Switch**

The Antenna Switch circuit consists of capacitor C64 and inductor L23 and takes the place of a quarter-wave micro strip line. When **TX9V** output goes high, bias current flows through switching diodes CD5, CD7 and CD9. A low impedance now exists at the anode of CD7 and a high impedance exists at the connection of C64 and L23. This isolates the transmitter power from the receiver. Diode CD5 is now an RF short and along with capacitor C55 couples the power to the lowpass filter and on to the antenna.

#### Tx 9V Switch

When the **TX ENB** lead goes low, TX 9V switch transistor TR4 conducts applying A+ (13.32 V) to the input of +9 Volt Regulator IC1. The regulated +9 volts (**TX 9V**) applies bias to operational amplifier IC2, transistor TR5 and switching diodes CD5, CD7 and CD9.

#### **Power Control**

The Auto Power Control (APC) circuit protects the transmitter PA from damage due to:

- a. excessive output power
- b. excessive reflected power

or

c. excessive temperature

The output power control circuit allows the RF output power to be set at rated power by the APC voltage from the Logic/IF/Audio Board. If the output power of the PA increases, the detected voltage and the input of operational amplifier IC2-2 increases. The output voltage of IC2-2 decreases. This causes **DC DRIVER** transistor TR6 to conduct less. This increases the base voltage on PNP **DC PASS** transistor TR7, causing it to conduct less. This results in less voltage being applied to the first amplifier stage in driver module (HC1), reducing the output power of the PA in proportion to the increases in output power detected by the circuit.

To protect the PA against badly mismatched loads, a reverse power detector circuit (VSWR) consisting of diode CD4, transistor TR6, operational amplifier IC2-2 and pass transistor TR7 detects reverse (reflected) power. When sufficient power is detected by CD4 to cause it to conduct, the voltage at the output of IC2-2 decreases, causing the driver module to lower the output power, protecting the PA. The re-

verse power level is set by resistor R15 connected in series with diode CD4.

The PA is protected against temperature increases by a thermal detector circuit. This circuit consists of resistor R49, transistors TR5, TR6, TR7 and operational amplifier IC2-2. As temperature increases, the resistance to ground through thermal detector resistor R49 increases. This causes IC2-2 to conduct less, causing a decrease in PA output until the temperature level is reduced. The temperature level is set by resistor R49. When the heatsink temperature rises above 90 C, the resistance of R49 increases and the power output is reduced.

#### 80/100 WATT

The 80/100 Watt PA assembly uses one power module (HC1) and three RF power transistors (TR1, TR2 and TR3) to provide the output power.

Supply voltage for the power amplifier is connected from power leads on the System Interface Board to J3 (A+) and G (A-) on the PA Board. Capacitors C73 and C95 prevent RF from getting on the power leads. Diode CD1 causes a fuse to blow if the polarity of the power leads is reversed. Diode CD2 is a surge protector to suppress pulses on the power leads.

Test Points (TP) are the printed board terminals for measuring control voltage as follows:

- TP1 A+ (13.32V)
- TP2 Control Voltage (4.27V)
- TP3 Forward Power Detect (3.2V)
- TP4 Tx 9V (9.2V)
- TP5 APC Voltage on output of DC AMPL IC2-1 (2.66V)
- TP6 Voltage to HC1, pins 3 &4 (12.8V)
- TP7 APC Voltage (3.5V)

The exciter output is coupled through connector J102 on the Synthesizer/Receiver/Exciter Board to input Jack P1 on the PA board. The 500 milliwatt RF input at P1 is coupled to power module HC1 through an attenuator pad consisting of resistors R1 through R4. This pad attenuates the 500 milliwatt input to 300 milliwatt and provides isolation between the Exciter and PA. **POWER MODULE** HC1 amplifies the 300 milliwatt input to 12 Watts. The power module (HC1) consists of a three stage RF amplifier. The first stage of the module is controlled by the voltage from the power control circuit. The amplifier consist of a Class C driver amplifier and two Class C common-emitter amplifiers. The 12 watt

output is coupled to DRIVER AMPL transistor TR1 through impedance matching components consisting of capacitors C7, C9 C10, inductors L2 through L4 and coupling capacitor C8. The output of TR1 is coupled to the power **SPLITTER** through the impedance matching components consisting of capacitors C11 through C13, C15, C96, C97, inductor L6 and impedance matching network Z1 through coupling capacitor C14. Transistor TR1 amplifies the 12 watt input level to 40 watts. The power splitter consists of capacitors C18, C27, C36 and Inductors L7 and L11. Resistor R5 absorbs any unbalance in the drive to POWER **AMPL-1. AMPL-2** transistors TR2 and TR3. These power amplifier stages consist of two identical paralleled Class C power amplifiers. The output of the power splitter is coupled to transistors TR2 and TR3 through coupling capacitors C19 and C28 and the impedance matching components consisting of capacitors C20, C21, C29 and C30. The output of TR2 and TR3 is coupled to the power combiner through impedance matching components consisting of capacitors C22-C25, C31-C34 and impedance matching networks Z2 and Z3. The power **COMBINER** consists of capacitors C26, C35, C40, C41 and inductors L10, L14 and L15, Resistor R8 absorbs the difference in the output power of TR2 and TR3. Transistors TR2 and TR3 each amplify the input level from 20 watts to about one-half (1/2) of the rated output power. The output of the combiner is coupled to the ANTENNA **SWITCH** through 50 ohm stripline Z7.

#### **Antenna Switch**

The antenna switch circuit consists of capacitor C64 and inductor L23 and takes the place of a quarter-wave micro strip line. When **TX9V** output goes high, bias current flows through switching diodes CD6 through CD9. A low impedance now exists at the anode of CD7 and CD8 and high impedance exists at the connection of C64 and L23. This isolates the transmitter power from the receiver. Diode CD6 is now an RF short and along with capacitor C55 couples the power to the lowpass filter and on to the antenna.

#### Tx 9V Switch

When the TX ENB lead goes low, TX 9V switch transistor TR4 conducts applying A+ (13.32 V) to the input of +9 Volt Regulator IC1. The regulated +9 volts (TX 9V) applies bias to operational amplifier IC2, transistor TR5 and switching diodes CD6 through CD9.

#### **Power Control**

The Automatic Power Control (APC) circuit protects the transmitter PA from damage due to:

- a. excessive output power
- b. excessive reflected power

or

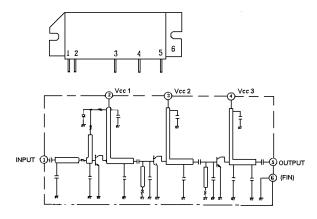
c. excessive temperature

The output power control circuit allows the RF output power to be set at rated power by the APC voltage from the LOGIC/IF/AUDIO Board. If the output power of the PA increases, the detected voltage and the input of operational amplifier IC2-2 increases. The output voltage of operational amplifier IC2-2 decreases. This causes transistor TR6 to conduct less. This increases the base voltage on PNP pass transistor TR7, causing it to conduct less. This results in less voltage being applied to the first amplifier stage in driver module (HC1), reducing the output power of the exciter/ PA in proportion to the increases in output power detected by the circuit.

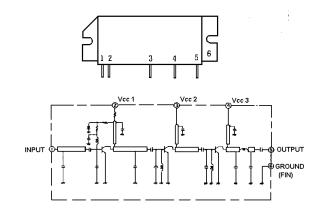
To protect the PA against badly mismatched loads, a reverse power detector circuit (VSWR) consisting of diode CD4, transistor TR6, operational amplifier IC2-2 and pass transistor TR7 detect reverse (reflected) power. When sufficient power is detected by CD4 to cause it to conduct, the voltage at the output of IC2-2 decreases, causing the driver module to lower the output power, protecting the PA. The reverse power level is set by resistor R15 connected in series with diode CD4.

The PA is protected against temperature increases by a thermal detector circuit. This circuit consists of resistor R49, transistors TR5, TR6, TR7 and operational amplifier IC2-2. As temperature increases, the resistance to ground through thermal detector resistor R49 increases. This causes IC2-2 to conduct less, causing a decrease in PA output until the temperature level is reduced. The temperature level is set by resistor R49. When the heatsink temperature rises above 90 C, the resistance of R49 increases and the power output is reduced.

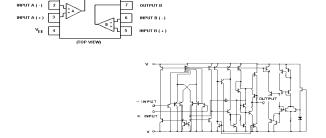
#### 403-512 MHz, 20-WATT POWER MODULE HC1



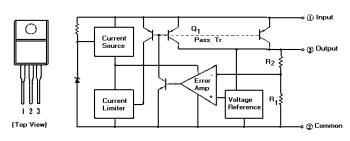
#### 403-512 MHz, 35/40 -WATT POWER MODULE HC1



#### 9 VOLT REGULATOR IC1



#### **OPERATIONAL AMPLIFIER IC2**



#### PA UNIT (EUROPEAN MODEL) 344A4573P1/JHM-471EA, 344A4573P2/JHM-471PEB

SYMBOL	PART NO.	DESCRIPTION
A1	NOTE: Parts listed are for reference	PA CIRCUIT CAH-545EA (Used in 344A4573P1).
A1	only. Refer to Service Section for	PA CIRCUIT CAH-545EB (Used in 344A4573P2).
A2	serviceable parts.	INTERFACE CMH-1231E.
		CAPACITORS
C1001 and C1002		Ceramic: 1000 pF +50%, -20% 50 VDCW temp coef $\pm$ 15%.
		CONNECTORS
J1001		H-6JALD00005.
TB1001		2 ALB-01A.
		WIRE
W1001		250V-HV-19/0.18-(2)
		COAXIAL CABLES
ZC1002		H-6JJLD17125A.
ZC1003		H-6JJLD17090A.
ZC1004		H-6ZCLD41060.

#### PA UNIT (USA MODEL)

344A573P3/JHM-471PLB 344A4573P5/JHM-471PLC 344A4573P7/JHM-471PHB 344A4573P7/JHM-471PHB

SYMBOL	PART NO.	DESCRIPTION
A1001	NOTE: Parts listed are for reference	PA CIRCUIT CAH-545LA (Used in 344A4573P3).
A1001	only. Refer to Service Section for	CIRCUIT CAH-545LB (Used in 344A4573P4).
A1001	serviceable parts.	PA CIRCUIT CAH-545LC (Used in 344A4573P5).
A1001		PA CIRCUIT CAH-545HA (Used in 344A4573P6).
A1001		PA CIRCUIT CAH-545HB (Used in 344A4573P7).
A1001		PA CIRCUIT CAH-545HC (Used in 344A4573P8).
A1002		INTERFACE (Used in 344A4573P3,P4,P5).
A1002		INTERFACE (Used in 344A4573P6,P7,P8).
		CAPACITORS
C1001		Ceramic: 1000 pF +200%,-0%, 50 VDCW temp coef +20%,-55%.
C1002		Ceramic: 1000 pF +200%,-0%, 50 VDCW temp coef +20%,-55% ( Used in P6,P7,P8).
C1004		Ceramic: 1000pF +50-20% 50 VDCW.
		DIODE
CD1001		Silicon fwd current 3A, 200 PIV ;sim to MOTOROLA MR751 (Used in 344A4573P3,P4,P5).
		JACKS
J1001		Connector: TNC-R888.

SYMBOL	PART NO.	DESCRIPTION
J1002		CCT9402-0501R.
J1004		2-171822-4.
J1004-1 thru J1004-4		170204-4.
		WIRES
W1001		250V-HV-19/0.18-(1).
W1002		250V-HV-19/0.18-(9).
W1003		250V-HV-19/0.18-(2).
W1004		250V-HV-19/0.18-(0).
		COAXIAL CABLES
ZC1002		H-6ZCLD41060.
ZC1003		H-6ZCLD40111 (Used in 344A4573P6,P7,P8).
ZC1003		H-6ZCLD40009 (Used in 344A4573P3,P4,P5).

#### POWER AMPLIFIER CAH-545E - 20 WATT CAH-545EA (Used in 344A4573P1) CAH-545EB (Used in 344A4573P2)

SYMBOL	PART NO.	DESCRIPTION
		CAPACITORS
C1 and C2	NOTE: Parts listed are for reference only. Refer to	Ceramic: 100 pF $\pm$ 5% 50 VDCW, temp coef 0 $\pm$ 30 PPM.
C3	Service Section for serviceable parts.	Electrolytic: 33 $\mu$ F $\pm$ 20% 25 VDCW, temp coef $\pm$ 20%.
C4		Film: 0.1 $\mu$ F ±10% 50 VDCW, temp coef ±15%.
C5		Ceramic: 4.7 pF $\pm$ 10% 50 VDCW, temp coef $\pm$ 10%.
C7		Ceramic: 100 pF $\pm$ 5% 50 VDCW, temp coef 0 $\pm$ 30 PPM.
C8		Ceramic: 7 pF $\pm$ 0.5pF 50 VDCW, temp coef 0 $\pm$ 30PPM. (Used in EA).
C8		Ceramic: 6 pF $\pm$ 0.5pF 50 VDCW, temp coef 0 $\pm$ 30PPM. (Used in EB).
C11		Ceramic: 7 pF $\pm$ 0.5pF 50 VDCW, temp coef 0 $\pm$ 30PPM. (Used in EA).
C11		Ceramic: 6 pF $\pm$ 0.5pF 50 VDCW, temp coef 0 $\pm$ 30PPM. (Used in EB).
C12		Ceramic: 100 pF $\pm$ 5% 500 VDCW, temp coef 0 $\pm$ 60 PPM.
C13 and C14		Ceramic: 3 pF $\pm$ 0.25pF 500 VDCW, temp coef 0 $\pm$ 120 PPM.
C15		Ceramic: 2 pF $\pm$ 0.25 PF 500 VDCW, temp coef 0 $\pm$ 250 PPM.
C16		Ceramic: 3 pF ±0.25pF 500 VDCW, temp coef 0±120 PPM.
C17		Ceramic: 5 pF $\pm$ 0.25pF 500 VDCW, temp coef 0 $\pm$ 60 PPM.
C19		Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM.
C20		Ceramic: 2 pF $\pm$ 0.25 PF 500 VDCW, temp coef 0 $\pm$ 250 PPM.
C21		Electrolytic: 220 $\mu$ F ±20% 25 VDCW, temp coef ±20%.

SYMBOL	PART NO.	DESCRIPTION
C22		Ceramic: 100 pF ±5% 50 VDCW, temp
thru C24		coef 0±30 PPM.
C25		Ceramic: 4 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM.
C26		Ceramic: 4 pF $\pm 0.25$ pF 50 VDCW, temp coef $0\pm 30$ PPM.
C27		Ceramic: 2 pF $\pm 0.25$ pF 50 VDCW, temp coef $0\pm 30$ PPM.
C28		Ceramic: 100 pF $\pm$ 5% 50 VDCW, temp coef 0 $\pm$ 30 PPM.
C30		Tantalum: 4.7 μF ±20% 25 VDCW.
C31		Electrolytic: 10 $\mu$ F $\pm$ 20% 25 VDCW, temp coef $\pm$ 20%.
C32		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30PPM.
C34		Electrolytic: 10 $\mu$ F $\pm$ 20% 25 VDCW, temp coef $\pm$ 20%.
C35		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C36		Tantalum: 1 uF ±20% 16 VDCW.
C37		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C38		Ceramic: 0.1 μF +80%,-20% 25 VDCW, temp coef +30%,-80%.
C39 and C40		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.
C43		Ceramic: 6 pF $\pm$ 0.5 pF 500 VDCW, temp coef 0 $\pm$ 60 PPM.
C44		Ceramic: 4 pF $\pm 0.25$ pF% 50 VDCW, temp coef $0\pm 30$ PPM.
C60 thru C62		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM.
		DIODES
CD1 and CD2		Silicon: sim to PANASONIC MA741-TX.
CD3 and CD4		PIN DIODE: sim to NIHONMEICOM H-6txld00001.
CD7		VARISTOR: sim to PANASONIC ERZ- CF2MK220.
CD8		Silicon: sim to MOTOROLA MR751.
CD9		Silicon: fast recovery (2 diodes in cathode common): sim to TOSHIBA
CD13		Silicon: fast recovery : sim to TOSHIBA ISS226.
		INTEGRATER OFFICE
HC1		RF Power Amplifier: sim to
HC1		MITSUBISHI M57788L-38 (Used in EA). RF Power Amplifier: sim to MITSUBISHI M57788H-38 (Used in
IC1		EB).
		Linear: Positive Voltage Regulator; sim to PANASONIC AN6541.
IC2		Linear: Dual OP Amp: sim to NEW JRC.
		CONNECTORS
J1 and J2		Connector.
J3		Connector.
J4	B19/5JTCD00197	Connector.
UT	D 10/00 10 D00 101	Connocioi.

SYMBOL	PART NO.	DESCRIPTION
		INDUCTORS
L1		Coil: 0.22 μH.
L2		Coil: RF 0.22 μH.
L3		Coil: 19 nH.
and L4		
L5		RF Coil: AIRWOUND.
thru L8		
L9 .		Coil: RF 19 nH.
and L10		
L11		Coil: RF 0.22 μH.
		RESISTORS
R1		Metal film: 470 ohms ±5%, 100 VDCW, 1/10W.
R2		Metal film: 12 ohms $\pm 5\%$ , 200 VDCW, 1/4W.
R3		Metal film: 470 ohms $\pm$ 5%, 100 VDCW, 1/10W.
R4 and R5		Metal film: 22 ohms ±5%, 200 VDCW, 1/2W.
R6		Metal film: 100 ohms ±5%, 250 VDCW, 1W.
R8		Metal film: 100 ohms ±5%, 100 VDCW, 1/10W.
R9 and		Metal film: 47 ohms ±5%, 100 VDCW, 1/10W.
R10 R11		Metal film: 47K ohms ±5%, 200 VDCW,
R14		1/8W.  Metal film: 47K ohms ±5%, 200 VDCW,  Metal film: 27K ohms ±5%, 100 VDCW,
R15		1/10W.
		Metal film: 2.7K ohms ±5%, 100 VDCW, 1/10W.
R16		Metal film: 390 ohms ±5%, 200 VDCW, 1/4W.
R17		Metal film: 470 ohms ±5%, 200 VDCW, 1/4W.
R18		Metal film: 1K ohms ±5%, 100 VDCW, 1/10W.
R19 thru		Metal film: 2.2K ohms ±5%, 200 VDCW, 1/10W.
R21		
R22		Metal film: 100k ohms ±5%, 100 VDCW, 1/10W.
R23		Metal film: 3.3K ohms $\pm 5\%$ , 100 VDCW, 1/10W.
R24		Metal film: 4.7k ohms $\pm 5\%$ , 100 VDCW, 1/10W.
R25		Metal film: 2.2K ohms $\pm 5\%$ , 100 VDCW, 1/10W.
R26		Metal film: 47K ohms ±5%, 100 VDCW, 1/10W.
R27		Metal film: 1K ohms ±5%, 100 VDCW, 1/10W.
R28		Posistor: sim to MURATA PTH9M04BE222TS2F333.
R35		Metal film: 100 ohms ±5%, 250 VDCW, 1W.
R36		Metal film: 10K ohms ±5%, 100 VDCW, 1/10W.
RV1		Variable: 10K ohms.

PARTS LIST LBI-39034

SYMBOL

C12

PART NO.

DESCRIPTION

Metal mica: 33 pF  $\pm 5\%$  100 VDCW, (Used in CH).

PART NO.	DESCRIPTION
	TRANSISTORS
	Silicon, NPN: sim to PANASONIC 2SD1445A.
	Silicon, NPN: sim to NEC 2SD596-T1B DV3.
	Silicon, PNP: sim to PANASONIC 2SB953A.
	Silicon, NPN: sim to NEC 2SD596-T1B DV3.
	Silicon, PNP: sim to NEC 2SB624-T1B BV3.
	Silicon, NPN: sim to NEC 2SD596-T1B DV3.
	Silicon, PNP: sim to NEC 2SB624-T1B BV3.
	PART NO.

UHF POWER AMPLIFIER
CAH-545L - 35/40 WATT
CAH-545H - 80/100 WATT
CAH-545LA (Used in 344A4573P3), CAH-545LB (Used in 344A4573P4)
CAH-545LC (Used in 344A4573P5), CAH-545HA (Used in 344A4573P6)
CAH-545HB (Used in 344A4573P7), CAN-545HC (Used in 344A4573P8)

SYMBOL	PART NO.	DESCRIPTION
		CAPACITORS
C1 and C2	NOTE: Parts listed are for reference only. Refer to	Ceramic: 100 pF $\pm$ 5% 50 VDCW, temp coef 0 $\pm$ 30 PPM.
СЗ	Service Section for serviceable parts.	Electrolytic: $33  \mu F \pm 20\%  25  VDCW$ , temp coef $\pm 20\%$ .
C5		Ceramic: 0.01 $\mu$ F ±10% 50 VDCW, temp coef 0±10%.
C6		Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef +30%,-80%.
C7		Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB,HA,).
C7		Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LC,HB,HC).
C8		Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM.
C9		Ceramic: 56 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA, HA).
C9		Ceramic: 47 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LB,LC,HB,HC).
C10		Ceramic: 56 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,HA).
C10		Ceramic: 43 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HB).
C10		Ceramic: 36 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LC,HC).
C10		Ceramic: 47 pF $\pm$ 5% 500 VDCW, temp coef 0 $\pm$ 60PPM (Used in LB).
C11		Metal mica: 43 pF $\pm 5\%$ 100 VDCW, (Used in LA, HA).
C11		Metal mica: 36 pF $\pm 5\%$ 100 VDCW, (Used in HB).
C11		Metal mica: 33 pF $\pm 5\%$ 100 VDCW, (Used in LB,HC).
C11		Metal mica: 39 pF $\pm 5\%$ 100 VDCW, (Used in LC).
C12		Metal mica: 47 pF $\pm 5\%$ 100 VDCW, (Used in LA).
C12		Metal mica: 43 pF $\pm 5\%$ 100 VDCW, (Used in HA,HB).

C12	Metal mica: 47 pF ±5% 100 VDCW (Used in LB,LC).
C13	Mica: 30 pF ±5% 500 VDCW (Used in LA,HA).
C13	Mica: 24 pF ±5% 500 VDCW (Used in HB).
C13	Mica: 22 pF ±5% 500 VDCW (Used in LC).
C13	Mica: 27 pF ±5% 500 VDCW (Used in LBI).
C14	Mica: 90 pF ±5% 500 VDCW (Used in LA,LB,LC).
C14	Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA, HB,HC).
C15	Ceramic: 5 pF ±0.25pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB).
C15	Ceramic: 4 pF ±0.25 pF 500 VDCW, temp coef 0±60PPM (Used in HC).
C16	Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM.
C17	Electrolytic: 22 $\mu$ F $\pm$ 10% 40 VDCW, (Used in HA, HB,HC).
C18	Ceramic: 10 pF $\pm$ 0.5pF 500 VDCW, temp coef 0 $\pm$ 60PPM (Used in HA).
C18	Ceramic: 9 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HB).
C18	Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HC).
C19	Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).
C20	Mica: 56 pF $\pm$ 5% 500 VDCW (Used in HA).
C20	Mica: 47 pF $\pm$ 5% 500 VDCW (Used in HB).
C20	Mica: 36 pF $\pm$ 5% 500 VDCW (Used in HC).
C21	Mica: 47 pF $\pm$ 5% 500 VDCW (Used in HA).
C21	Mica: 39 pF $\pm$ 5% 500 VDCW (Used in HB).
C21	Mica: 36 pF $\pm$ 5% 500 VDCW (Used in HC).
C22	Metal mica: 43 pF $\pm$ 5% 100 VDCW (Used in HA).
C22	Metal mica: 36 pF $\pm$ 5% 100 VDCW (Used in HB,HC).
C23	Metal mica: 43 pF $\pm$ 5% 100 VDCW (Used in HA,HB).
C23	Metal mica: 33 pF $\pm 5\%$ 100 VDCW (Used in HC).
C24	Metal mica: 30 pF $\pm 5\%$ 100 VDCW (Used in HA).
C24	Metal mica: 27 pF $\pm 5\%$ 100 VDCW (Used in HB).
C24	Metal mica: 24 pF $\pm 5\%$ 100 VDCW (Used in HC).
C25	Mica: 90 pF $\pm$ 5% 500 VDCW (Used in HA,HB,HC).
C26	Ceramic: 10 pF $\pm$ 0.5pF 500 VDCW, temp coef 0 $\pm$ 60PPM (Used in HA,HB.
C26	Ceramic: 8 pF $\pm 0.5$ pF 500 VDCW, temp coef 0 $\pm 6$ 0PPM (Used in HC).
C27	Ceramic: 10 pF $\pm$ 0.5pF 500 VDCW, temp coef 0 $\pm$ 60PPM (Used in HA).
C27	Ceramic: 9 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HB).

C36         Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C37         Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).           C38         Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef +30%, -80% (Used in HA,HB,HC).           C39         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C40         Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Mica: 8 pF ±0.5pF 500 VDCW (Used in HB).           C41         Mica: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LA,LB).           C41         Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).           C41         Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±30PPM (Used in HA).           C44         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HA).           C44         Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HA,LB,LC).           C45         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C45         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C45         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).           C47         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C48         Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	OVMDO	DARTNO	PEOGRAPION
C29         Mica: 36 pF ±5% 500 VDCW (Used in HA).           C30         Mica: 56 pF ±5% 500 VDCW (Used in HA).           C30         Mica: 47 pF ±5% 500 VDCW (Used in HB).           C31         Metal mica: 43 pF ±5% 500 VDCW (Used in HC).           C31         Metal mica: 43 pF ±5% 100 VDCW (Used in HA, HB).           C31         Metal mica: 33 pF ±5% 100 VDCW (Used in HC).           C32         Metal mica: 36 pF ±5% 100 VDCW (Used in HA).           C33         Metal mica: 36 pF ±5% 100 VDCW (Used in HB, HC).           C33         Metal mica: 27 pF ±5% 100 VDCW (Used in HB, HC).           C33         Metal mica: 24 pF ±5% 100 VDCW (Used in HB).           C33         Metal mica: 24 pF ±5% 100 VDCW (Used in HB).           C33         Metal mica: 24 pF ±5% 100 VDCW (Used in HA,HB,HC).           C34         Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).           C35         Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C36         Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C37         Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).           C38         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C40         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Mica: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,		PART NO.	
C30         Mica: 56 pF ±5% 500 VDCW (Used in HA).           C30         Mica: 47 pF ±5% 500 VDCW (Used in HB).           C30         Mica: 36 pF ±5% 500 VDCW (Used in HC).           C31         Metal mica: 43 pF ±5% 100 VDCW (Used in HC).           C31         Metal mica: 33 pF ±5% 100 VDCW (Used in HA,HB).           C32         Metal mica: 36 pF ±5% 100 VDCW (Used in HA).           C32         Metal mica: 36 pF ±5% 100 VDCW (Used in HB,HC).           C33         Metal mica: 27 pF ±5% 100 VDCW (Used in HA).           C33         Metal mica: 24 pF ±5% 100 VDCW (Used in HC).           C34         Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).           C35         Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB).           C35         Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB).           C36         Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C37         Electrolytic: 22 µF ±10% 40 VDCW (Used in HA,HB,HC).           C38         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C40         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Mica: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Mica: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Ceramic: 10 p			
C30         Mica: 36 pF ±5% 500 VDCW (Used in HC).           C31         Metal mica: 43 pF ±5% 100 VDCW (Used in HA,HB).           C31         Metal mica: 33 pF ±5% 100 VDCW (Used in HA,HB).           C32         Metal mica: 36 pF ±5% 100 VDCW (Used in HA).           C32         Metal mica: 30 pF ±5% 100 VDCW (Used in HB,HC).           C33         Metal mica: 30 pF ±5% 100 VDCW (Used in HA).           C33         Metal mica: 27 pF ±5% 100 VDCW (Used in HB).           C33         Metal mica: 24 pF ±5% 100 VDCW (Used in HB).           C33         Metal mica: 24 pF ±5% 100 VDCW (Used in HC).           C34         Mica: 90 pF ±5% 500 VDCW (Used in HC).           C35         Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB).           C35         Ceramic: 3 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C36         Ceramic: 3 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C37         Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).           C38         Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C40         Ceramic: 3 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Mica: 8 pF ±0.5pF 50 VDCW, (Used in HB).           C41         Mica: 8 pF ±0.5pF 50 VDCW, temp coef 0±60PPM (Used in LA,LB).           C41         Ceramic: 10 pF ±0.5pF 50	C30		
C31         Metal mica: 43 pF ±5% 100 VDCW (Used in HA,HB).           C32         Metal mica: 33 pF ±5% 100 VDCW (Used in HC).           C32         Metal mica: 36 pF ±5% 100 VDCW (Used in HA).           C32         Metal mica: 36 pF ±5% 100 VDCW (Used in HB,HC).           C33         Metal mica: 30 pF ±5% 100 VDCW (Used in HA).           C33         Metal mica: 27 pF ±5% 100 VDCW (Used in HB).           C33         Metal mica: 24 pF ±5% 100 VDCW (Used in HB).           C34         Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).           C35         Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C35         Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C36         Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C37         Electrolytic: 22 µF ±10% 40 VDCW (Used in HA,HB,HC).           C38         Ceramic: 0.1 µF +80%, -20% 50 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C39         Ceramic: 0.1 µF +80%, -20% 50 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C40         Ceramic: 10 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Mica: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,LB).           C41         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA)	C30		Mica: 47 pF $\pm$ 5% 500 VDCW (Used in HB).
HA,HB).  Metal mica: 33 pF ±5% 100 VDCW (Used in HC).  C32  Metal mica: 43 pF ±5% 100 VDCW (Used in HA).  Metal mica: 36 pF ±5% 100 VDCW (Used in HB,HC).  C33  Metal mica: 30 pF ±5% 100 VDCW (Used in HB,HC).  C33  Metal mica: 27 pF ±5% 100 VDCW (Used in HB).  C33  Metal mica: 27 pF ±5% 100 VDCW (Used in HB).  C34  Mica: 20 pF ±5% 500 VDCW (Used in HC).  C35  Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM. (Used in HA,HB,HC).  C36  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C37  Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).  C38  Ceramic: 10 pF ±6% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C39  Ceramic: 10 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C40  Ceramic: 10 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41  Mica: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41  Ceramic: 10 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41  Ceramic: 12 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41  Ceramic: 12 pF ±0.5pF 50 VDCW, temp coef 0±60PPM (Used in HA,LB).  C41  Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C44  Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C45  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C46  Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C47  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C47  Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C47  Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB).  C49  Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB).  C49  Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).	C30		Mica: 36 pF ±5% 500 VDCW (Used in HC).
HC).  Metal mica: 43 pF ±5% 100 VDCW (Used in HA).  C32  Metal mica: 36 pF ±5% 100 VDCW (Used in HB,HC).  C33  Metal mica: 30 pF ±5% 100 VDCW (Used in HB).  C33  Metal mica: 27 pF ±5% 100 VDCW (Used in HB).  C33  Metal mica: 24 pF ±5% 100 VDCW (Used in HB).  C34  Mica: 30 pF ±5% 500 VDCW (Used in HC).  C35  Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM. (Used in HA,HB,HC).  C36  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C37  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C38  Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C39  Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C40  Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41  Mica: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41  Mica: 8 pF ±0.5pF 500 VDCW, (Used in HB).  C41  Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,HB).  C41  Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±60PPM (Used in LA,HB).  C41  Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±60PPM (Used in LA,HB).  C41  Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±60PPM (Used in LA,HB).  C41  Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA,HC).  C44  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA,LC).  C45  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA,LC).  C46  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA,LC).  C47  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47  Ceramic: 10 pF ±5% 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47  Ceramic: 10 pF ±5% 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47  Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47  Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C49  Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM.	C31		Metal mica: 43 pF $\pm 5\%$ 100 VDCW (Used in HA,HB).
HA).         Metal mica: 36 pF ±5% 100 VDCW (Used in HB,HC).           C33         Metal mica: 30 pF ±5% 100 VDCW (Used in HA).           C33         Metal mica: 27 pF ±5% 100 VDCW (Used in HB).           C33         Metal mica: 24 pF ±5% 100 VDCW (Used in HB).           C34         Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).           C35         Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB).           C35         Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C36         Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C37         Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).           C38         Ceramic: 010 μF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C40         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Mica: 8 pF ±0.5pF 500 VDCW, (Used in HB).           C41         Mica: 8 pF ±0.5pF 500 VDCW, (Used in HA).           C41         Mica: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LA,LB).           C41         Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA).           C44         Ceramic: 5 pF ±0.5pF 500 VDCW, temp coef 0±30PPM (Used in HA).           C44         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).           C45         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HA).	C31		
HB,HC).  Metal mica: 30 pF ±5% 100 VDCW (Used in HA).  C33  Metal mica: 27 pF ±5% 100 VDCW (Used in HB).  C33  Metal mica: 24 pF ±5% 100 VDCW (Used in HB).  C34  Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).  C35  Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C36  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA).  C37  Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).  C38  Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C39  Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41  Mica: 8 pF ±0.5pF 500 VDCW (Used in HA,HB).  C41  Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).  C41  Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB).  C41  Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB).  C41  Ceramic: 5 pF ±0.5pF 500 VDCW, temp coef 0±30PPM (Used in HB,HC).  C44  Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  C45  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  C46  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  C47  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  Ceramic: 8 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  Ceramic: 9 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  Ceramic: 10 pF ±5% 50 VDCW, temp coef 0±30 PPM. (Used in HA).  Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±30 PPM. (Used in HA).  Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±30 PPM. (Used in HA).  Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C32		
HA).  Metal mica: 27 pF ±5% 100 VDCW (Used in HB).  C33  Metal mica: 24 pF ±5% 100 VDCW (Used in HC).  Mica: 90 pF ±5% 500 VDCW (Used in HC).  C34  Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).  C35  Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM. (Used in HA,HB).  C35  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HC).  C36  Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C37  Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).  C38  Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C40  Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41  Mica: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41  Mica: 8 pF ±0.5pF 500 VDCW, (Used in HA,HB,HC).  C41  Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).  C41  Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).  C41  Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB).  C41  Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA,LB).  C44  Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  C45  Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HA,LB,LC).  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C45  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C46  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C48  Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30PPM (Used in HA).  C49  Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30PPM. (Used in HA).  Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30PPM. (Used in HA).	C32		
C33       Metal mica: 24 pF ±5% 100 VDCW (Used in HC).         C34       Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).         C35       Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM. (Used in HA,HB).         C35       Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB).         C36       Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).         C37       Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).         C38       Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).         C39       Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).         C40       Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).         C41       Mica: 8 pF ±0.5pF 500 VDCW, (Used in HA,HB).         C41       Mica: 6 pF ±0.5pF 50 VDCW, (Used in HA,HB).         C41       Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).         C41       Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).         C44       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA,HC).         C44       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA,HC).         C45       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA,HC).         C45       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA,HC).         C45       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,H	C33		
HC).  Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).  C35  Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM. (Used in HA,HB).  C35  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HC).  C36  Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C37  Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).  C38  Ceramic: 0.1 μF +80%, -20% 50 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C39  Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C40  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41  Mica: 6 pF ±0.5pF 500 VDCW (Used in HB).  C41  Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).  C41  Ceramic: 12 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA).  C41  Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA).  C44  Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±30PPM (Used in HA).  C44  Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  C45  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  C45  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  C45  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  C47  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C48  Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  C47  Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30PPM. (Used in HA).  C48  C49  Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).  Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C33		
C35       Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM. (Used in HA,HB).         C35       Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HC).         C36       Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).         C37       Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).         C38       Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef +30%, -80% (Used in HA,HB,HC).         C39       Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).         C40       Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).         C41       Mica: 8 pF ±0.5pF 500 VDCW (Used in HB).         C41       Mica: 6 pF ±0.5pF 500 VDCW, (Used in HA,HB).         C41       Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).         C41       Ceramic: 12 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LA).         C41       Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±30PPM (Used in HA).         C44       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).         C44       Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).         C45       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).         C45       Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30PPM (Used in HB,HC).         C47       Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM. (Used in HA).         C48       Ceramic: 7 pF ±0.5 pF, 50	C33		
C35         Coef 0±60PPM. (Used in HA,HB).           C36         Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HC).           C36         Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C37         Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).           C38         Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef +30%, -80% (Used in HA,HB,HC).           C39         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C40         Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Mica: 8 pF ±0.5pF 500 VDCW (Used in HB).           C41         Mica: 6 pF ±0.5pF 50 VDCW, (Used in HA,HB).           C41         Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).           C41         Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C44         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C44         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C45         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C45         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).           C47         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB).           C48         Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).           C49         Ceramic: 7 p	C34		
C36         Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C37         Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).           C38         Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef +30%, -80% (Used in HA,HB,HC).           C39         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C40         Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Mica: 8 pF ±0.5pF 500 VDCW (Used in HB).           C41         Mica: 6 pF ±0.5pF 50 VDCW, (Used in HA,HB).           C41         Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).           C41         Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±60PPM (Used in LA).           C41         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C44         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C44         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C45         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C45         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).           C47         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C48         Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM.           C49         Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM.           C49         Ceramic: 7 pF ±0.5	C35		Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM. (Used in HA,HB).
C37         Electrolytic: 22 μF ±10% 40 VDCW (Used in HA,HB,HC).           C38         Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef +30%, -80% (Used in HA,HB,HC).           C39         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C40         Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Mica: 8 pF ±0.5pF 500 VDCW (Used in HB).           C41         Mica: 6 pF ±0.5pF 50 VDCW, (Used in HA,HB).           C41         Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).           C41         Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LA,LB).           C41         Ceramic: 10 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C44         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).           C44         Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).           C45         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).           C45         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).           C47         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C48         Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).           C49         Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).           C49         Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C35		Ceramic: 8 pF $\pm 0.5$ pF 500 VDCW, temp coef 0 $\pm 6$ 0PPM (Used in HC).
C38       Ceramic: 0.1 μF +80%,-20% 50 VDCW, temp coef +30%, -80% (Used in HA,HB,HC).         C39       Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).         C40       Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).         C41       Mica: 8 pF ±0.5pF 500 VDCW (Used in HB).         C41       Mica: 6 pF ±0.5pF 500 VDCW, (Used in HA,HB).         C41       Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).         C41       Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LA,LB).         C44       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).         C44       Ceramic: 5 pF ±0.25pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).         C44       Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA,LB,LC).         C45       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).         C45       Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).         C47       Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.         C48       Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).         C49       Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).         C49       Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C36		Ceramic: 6 pF $\pm$ 0.5pF 500 VDCW, temp coef 0 $\pm$ 60PPM (Used in HA,HB,HC).
Coef +30%, -80% (Used in HA,HB,HC).  Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).  C41 Mica: 8 pF ±0.5pF 500 VDCW (Used in HB).  C41 Mica: 6 pF ±0.5pF 500 VDCW, (Used in HA,HB).  C41 Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).  C41 Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LC).  C44 Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C44 Ceramic: 5 pF ±0.25pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  C44 Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in LA,LB,LC).  C45 Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C45 Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47 Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47 Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C48 Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM.  C49 Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).  C49 Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C37		Electrolytic: 22 $\mu\text{F}$ ±10% 40 VDCW (Used in HA,HB,HC).
C40         0±60PPM (Used in HA,HB,HC).           C41         Ceramic: 8 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in HA,HB,HC).           C41         Mica: 8 pF ±0.5pF 500 VDCW (Used in HB).           C41         Mica: 6 pF ±0.5pF 50 VDCW, (Used in HA,HB).           C41         Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).           C41         Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LC).           C44         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C44         Ceramic: 5 pF ±0.25pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).           C44         Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA,LB,LC).           C45         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).           C45         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).           C47         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C48         Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).           C49         Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).           C49         Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C38		Ceramic: 0.1 $\mu$ F +80%,-20% 50 VDCW, temp coef +30%, -80% (Used in HA,HB,HC).
0±60PPM (Used in HA,HB,HC).  C41 Mica: 8 pF ±0.5pF 500 VDCW (Used in HB).  Mica: 6 pF ±0.5pF 50 VDCW, (Used in HA,HB).  C41 Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).  C41 Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LC).  C44 Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C44 Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  C44 Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in LA,LB,LC).  C45 Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  C45 Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47 Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47 Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.  C48 Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).  C49 Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef	C39		Ceramic: 100 pF $\pm$ 5% 500 VDCW, temp coef 0 $\pm$ 60PPM (Used in HA,HB,HC).
C41       Mica: 6 pF ±0.5pF 50 VDCW, (Used in HA,HB).         C41       Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).         C41       Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LC).         C44       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).         C44       Ceramic: 5 pF ±0.25pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).         C44       Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in LA,LB,LC).         C45       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).         C45       Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).         C47       Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.         C48       Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).         C49       Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).         C49       Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C40		Ceramic: 8 pF $\pm 0.5$ pF 500 VDCW, temp coef 0 $\pm 60$ PPM (Used in HA,HB,HC).
HA,HB).  Ceramic: 12 pF ±5% 500 VDCW, temp coef 0±60PPM (Used in LA,LB).  Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LC).  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  Ceramic: 5 pF ±0.25pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).  Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in LA,LB,LC).  Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).  Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.  Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM.  Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).  Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C41		Mica: 8 pF $\pm$ 0.5pF 500 VDCW (Used in HB).
C41         O±60PPM (Used in LA,LB).           C42         Ceramic: 10 pF ±0.5pF 500 VDCW, temp coef 0±60PPM (Used in LC).           C44         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C44         Ceramic: 5 pF ±0.25pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).           C44         Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in LA,LB,LC).           C45         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C45         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).           C47         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C48         Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).           C49         Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).           C49         Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C41		
C44         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C44         Ceramic: 5 pF ±0.25pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).           C44         Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in LA,LB,LC).           C45         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C45         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).           C47         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C48         Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).           C49         Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).           C49         Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C41		
0±30PPM (Used in HA).         C44       Ceramic: 5 pF ±0.25pF 50 VDCW, temp coef 0±30PPM. (Used in HB,HC).         C44       Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in LA,LB,LC).         C45       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).         C45       Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).         C47       Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.         C48       Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).         C49       Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef	C41		
0±30PPM. (Used in HB,HC).           C44         Ceramic: 7 pF ±0.5pF 50 VDCW, temp coef 0±30PPM. (Used in LA,LB,LC).           C45         Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).           C45         Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).           C47         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C48         Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).           C49         Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C44		
0±30PPM. (Used in LA,LB,LC).         C45       Ceramic: 6 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HA).         C45       Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).         C47       Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.         C48       Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).         C49       Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).	C44		Ceramic: 5 pF $\pm 0.25$ pF 50 VDCW, temp coef $0\pm 30$ PPM. (Used in HB,HC).
0±30PPM (Used in HA).  Ceramic: 5 pF ±0.5pF 50 VDCW, temp coef 0±30PPM (Used in HB,HC).  C47 and 0±30 PPM.  C48  C49  Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.  C48  Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).  C49  Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef	C44		
0±30PPM (Used in HB,HC).  C47 and C48  C49  Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.  Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).  C49  Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef	C45		
and C48       0±30 PPM.         C49       Ceramic: 8 pF ±0.5 pF, 50 VDCW, temp coef 0±30 PPM. (Used in HA).         C49       Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef	C45		
0±30 PPM. (Used in HA).  C49 Ceramic: 7 pF ±0.5 pF, 50 VDCW, temp coef	and		
	C49		Ceramic: 8 pF $\pm 0.5$ pF, 50 VDCW, temp coef 0 $\pm 30$ PPM. (Used in HA).
	C49		Ceramic: 7 pF $\pm 0.5$ pF, 50 VDCW, temp coef 0 $\pm 30$ PPM. (Used in HB).
C49 Ceramic: ±0.5 pF ±0.25 pF, 50 VDCW, temp coef 0±30 PPM (Used in LC).	C49		Ceramic: $\pm 0.5$ pF $\pm 0.25$ pF, 50 VDCW, temp coef $0\pm 30$ PPM (Used in LC).
C50 Ceramic: 4 pF ±0.25 pF, 50 VDCW, temp coef 0±30 PPM (Used in HC).	C50		
` '	C50		Ceramic: 6 pF ±0.5 pF, 50 VDCW, temp coef

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C51		Ceramic: 100 pF ±5%, 50 VDCW, temp coef 0±30 PPM.	
C52		Ceramic: 1000 pF ±10% 50 VDCW, temp coef 0±15% ±15% (Used in HA,HB,HC).	
C53		Ceramic: 100 pF $\pm$ 5% 50 VDCW, temp coef 0 $\pm$ 30PPM.	
C54		Ceramic: 100 pF $\pm$ 5% 50 VDCW, temp coef 0 $\pm$ 30 PPM.	
C55		Ceramic: 100 pF $\pm$ 5% 500 VDCW, temp coef 0 $\pm$ 60 PPM.	
C56		Ceramic: 3 pF $\pm$ 0.25 pF 500 VDCW, temp coef 0 $\pm$ 120 PPM (Used in HA,HB).	
C56		Ceramic: 4 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM (Used in LA,LB,LC,HC).	
C57		Ceramic: 6 pF $\pm 0.5$ pF 500 VDCW, temp coef 0 $\pm 60$ PPM (Used in HC).	
C57		Ceramic: 5 pF $\pm$ 0.5pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in HB).	
C57		Ceramic: 7 pF $\pm 0.5$ pF 500 VDCW, temp coef 0 $\pm 60$ PPM (Used in LA,LB,LC,HA).	
C58		Ceramic: 3 pF ±0.25 pF 500 VDCW, temp coef 0±120 PPM (Used in LA,HA,HB).	
C58		Ceramic: 2 pF $\pm$ 0.25 pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in LB,LC,HC).	
C59		Ceramic:2 pF $\pm$ 0.25pF 500 VDCW, temp coef 0 $\pm$ 250 PPM (Used in HC).	
C59		Ceramic: 3 pF ±0.25 pF 500 VDCW, temp coef 0±120 PPM (Used in HA,HB,LC).	
C59		Ceramic: 5 pF $\pm$ 0.25pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in LA).	
C59		Ceramic: 4 pF $\pm$ 0.25 pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in LB).	
C60		Ceramic: 4 pF $\pm$ 0.25 pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in HC).	
C60		Ceramic: 3 pF $\pm$ 0.25 pF 500 VDCW, temp coef 0 $\pm$ 120 PPM (Used in HA,HB).	
C60		Ceramic: 6 pF $\pm$ 0.25pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in LA,LB).	
C60		Ceramic: 7 pF $\pm$ 0.5pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in LC).	
C61		Ceramic: 2 pF $\pm$ 0.25 pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in LA,HA,HB).	
C61		Ceramic: 1 pF $\pm$ 0.25 pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in LB,LC,HC).	
C62		Ceramic: 7 pF $\pm$ 0.5 pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in LA,LB,LC,HA).	
C62		Ceramic: 6 pF $\pm$ 0.5pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in HB,HC).	
C63		Ceramic: 4 pF $\pm$ 0.25 pF 500 VDCW, temp coef 0 $\pm$ 60 PPM (Used in LA,LB,LC,HA,HB).	
C63		Ceramic: 3 pF $\pm$ 0.25pF 500 VDCW, temp coef 0 $\pm$ 120 PPM (Used in HC).	
C64 C64		Mica: 2 pF $\pm$ 0.25pF 500 VDCW (Used in HB). Mica: 1.5 pF $\pm$ 0.25pF 500 VDCW (Used in	
C64		HC). Ceramic: 5 pF ±0.25pF 500 VDCW, temp	
C64		coef 0±60 PPM (Used in LA).  Ceramic: 4 pF ±0.25 pF 500 VDCW, temp	
C64		coef 0±60 PPM (Used in LB).  Ceramic: 3 pF ±0.25pF 500 VDCW, temp	
C64		coef 0±120 PPM (Used in LC).  Mica: 3 pF ±0.25pF 500 VDCW (Used in HA).	
C65		Ceramic: 6 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM (Used in HA,HB).	
C65		Ceramic: 5 pF ±0.5pF 500 VDCW, temp coef 0±60 PPM (Used in LA).	

\*COMPONENTS, ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

(Continued)

PARTS LIST LBI-39034

C65         Ceramic: 4 pF ± 0.25 pF 500 VDCW, temp coef 0±60 PPM (Used in LB, LC, HC)           C66         Ceramic: 4 pF ± 0.25 pF 500 VDCW, temp coef 0±60 PPM (Used in LA, LB).           C66         Ceramic: 7 pF ± 0.5 pF 500 VDCW, temp coef 0±60 PPM (Used in LA).           C66         Ceramic: 3 pF ± 0.5 pF 500 VDCW, temp coef 0±120 PPM (Used in HB).           C66         Ceramic: 3 pF ± 0.25 pF 500 VDCW, temp coef 0±120 PPM (Used in HC).           C67         Ceramic: 3 pF ± 0.25 pF 50 VDCW, temp coef 0±30 PPM (Used in AH,BH,CH).           C67         Ceramic: 3 pF ± 0.25 pF 50 VDCW, temp coef 0±30 PPM (Used in AH,BH,CH).           C68         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C71         Tantalum: 10 pF ±20%,35 VDCW (Used in HA,HB,HC).           C71         Tantalum: 10 pF ±20%,35 VDCW (Used in HA,HB,HC).           C72         Electrolytic: 10 µF ±10%.           C73         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C84         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C88         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C88         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C89         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 47 µF ±10% 16 VDCW.	SYMBOL	PART NO.	DESCRIPTION	
C66         Ceramic: 4 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM (Used in LA,LB).           C66         Ceramic: 7 pF ±0.5 pF 500 VDCW, temp coef 0±60 PPM (Used in LA,LB).           C66         Ceramic: 3 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM (Used in LC).           C66         Ceramic: 3 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM (Used in HC).           C67         Ceramic: 5 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM (Used in AH,BH,CH).           C67         Ceramic: 3 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM (Used in AH,BH,CH).           C68         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in AH,BH,CH).           C69         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C71         Tantalum: 10 µF ±20%,35 VDCW (Used in HA,HB,HC).           C71         Tantalum: 10 µF ±20%,50 VDCW (Used in HA,HB,HC).           C72         Electrolytic: 10 µF ±10%.           C73         Ceramic: 100 pF ±5% 50 VDCW (Used in HA,HB,HC).           C84         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C85         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C88         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C89         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C89         Ceramic: 101 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C89         Ceramic: 101 pF ±5% 50 VDCW, temp coef 0±30 PPM.		TAKT NO.		
C66         Ceramic: 7 pF ±0.5 pF 500 VDCW, temp coef 0±60 PPM (Used in HB).           C66         Ceramic: 3 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM (Used in HB).           C66         Ceramic: 3 pF ±0.25 pF 500 VDCW, temp coef 0±60 PPM (Used in HC).           C67         Ceramic: 2 pF ±0.25 pF 500 VDCW, temp coef 0±30 PPM (Used in AH, BH, CH).           C67         Ceramic: 2 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM (Used in AH, BH, CH).           C68         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA, HB, HC).           C71         Tantalum: 10 pF ±5% 50 VDCW (Used in HA, HB, HC).           C71         Tantalum: 10 pF ±20%, 35 VDCW (Used in HA, HB, HC).           C72         Electrolytic: 10 pF ±10%.           C63         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA, HB, HC).           C72         Electrolytic: 10 pF ±5% 50 VDCW, temp coef 0±60 PPM (Used in HA, HB, HC).           C82         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C83         Tantalum: 1 μF ±20% 16 VDCW,           C84         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C85         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C86         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA, HB, HC).           C90         Ceramic: 30 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA, HB, HC).           C91         Electrolytic: 30 µF ±5% 500 VD	C03			
0±60 PPM (Used in HB).           Ceramic: 3 pF ±0.25pF 500 VDCW, temp coef 0±120 PPM (Used in LC).           C66         Ceramic: 5 pF ±0.25pF 500 VDCW, temp coef 0±30 PPM (Used in HC).           C67         Ceramic: 2 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM (Used in AH,BH,CH).           C67         Ceramic: 3 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM (Used in AH,BH,CH).           C68         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C71         Tantalum: 10 pF ±20%,35 VDCW (Used in HA,HB,HC).           C71         Tantalum: 10 pF ±20%,35 VDCW (Used in HA,HB,HC).           C72         Electrolytic: 10 pF ±10%.           C73         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C82         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C83         Tantalum: 1 pF ±20% 16 VDCW,           C84         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C88         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C89         Ceramic: 0.1 µF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4.7 µF ±10% 16 VDCW,           C92         Electrolytic: 100 µF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C94         Ceramic: 0.1 µF ±5% 50 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).	C66		coef 0±60 PPM (Used in LA,LB).	
C66         Ceramic: 5 pF ±0.25pF 500 VDCW, temp coef 0±60 PPM (Used in HC).           C67         Ceramic: 2 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM (Used in HA).           C67         Ceramic: 3 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM (Used in LA).           C68         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C69         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA, HB, HC).           C71         Tantalum: 10 µF ±20% 16 VDCW (Used in HA, HB, HC).           C71         Tantalum: 10 µF ±20% 16 VDCW (Used in HA, HB, HC).           C72         Electrolytic: 10 µF ±10%.           C73         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±60 PPM (Used in HA, HB, HC).           C82         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C83         Tantalum: 1 µF ±20% 16 VDCW,           C84         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C88         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA, HB, HC).           C91         Tantalum: 4 µF ±10% 16 VDCW,           C92         Electrolytic: 100 µF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA, HB, HC).           C93         Mica: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA, HB, HC).           C94         Ceramic: 100 µF ±5% 50 VDCW, temp coef 0±60 PPM (Used in HA, HB, HC).           C95         Electrolytic: 33 µF ±10% 25 VDCW,           C96	C66			
C67         Coeramic: 2 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM (Used in AH,BH,CH).           C67         Ceramic: 3 pF ±0.25 pF 50 VDCW, temp coef 0±30 PPM (Used in LA).           C68         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C69         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C71         Tantalum: 10 µF ±20%,35 VDCW (Used in HA,HB,HC).           C71         Tantalum: 10 µF ±20% 16 VDCW (Used in LA,LB,LC).           C72         Electrolytic: 10 µF ±10%.           C73         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C73         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±60 PPM.           C84         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C83         Tantalum: 1 µF ±20% 16 VDCW,           C84         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C88         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C89         Ceramic: 100 pF ±5% 50 VDCW,           C90         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4,7 µF ±10% 16 VDCW,           C92         Electrolytic: 130 µF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C96         Ceramic: 15 pF ±5% 50 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).	C66			
C67         Ceramic: 3 p F±0.25 p F 50 VDCW, temp coef 0±30 PPM (Used in LA).           C68         Ceramic: 100 p F±5% 50 VDCW, temp coef 0±30 PPM (Used in LA).           C69         Ceramic: 100 p F±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C71         Tantalum: 10 μF±20%,35 VDCW (Used in HA,HB,HC).           C71         Tantalum: 10 μF±20% 16 VDCW (Used in LA,LB,LC).           C72         Electrolytic: 10 μF±10%.           C73         Ceramic: 100 pF±5% 50 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C81         Ceramic: 100 pF±5% 50 VDCW, temp coef 0±30 PPM.           C83         Tantalum: 1 μF±20% 16 VDCW,           C84         Ceramic: 100 pF±5% 50 VDCW, temp coef 0±30 PPM.           C88         Ceramic: 100 pF±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4.7 μF±10% 16 VDCW,           C92         Electrolytic: 100 μF±20% 50 VDCW,           C93         Mica: 100 pF±5% 500 VDCW,           C94         Electrolytic: 33 μF±10% 25 VDCW,           C95         Electrolytic: 33 μF±10% 25 VDCW,           C96         Ceramic: 15 pF±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF±5% 500 VDCW (Used in HC).           C98         Mica: 22 pF±5% 500 VDCW, temp coef 0±60 PPM (Used in LA,LB,LC).           C99         Ceramic: 330 pF±5	C66			
C68         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C69         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM. (Used in HA,HB,HC).           C71         Tantalum: 10 μF ±20%,35 VDCW (Used in HA,HB,HC).           C71         Tantalum: 10 μF ±20% 16 VDCW (Used in HA,HB,HC).           C72         Electrolytic: 10 μF ±10%.           C73         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±30 PPM. (Used in HA,HB,HC).           C82         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C83         Tantalum: 1 μF ±20% 16 VDCW,           C84         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C88         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM. (Used in HA,HB,HC).           C90         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4.7 μF ±10% 16 VDCW,           C92         Electrolytic: 100 μF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 500 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5%,500 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C98         Mica: 29 pF ±5% 500 VDCW (Used in HC).           Mica: 29 pF ±5% 500 VDCW (Used in HA,HB,HC).           C99         Ceramic: 330 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           CD1         Silicon: favt c	C67			
C69         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C71         Tantalum: 10 μF ±20%,35 VDCW (Used in HA,HB,HC).           C71         Tantalum: 10 μF ±20%,35 VDCW (Used in HA,HB,HC).           C72         Electrolytic: 10 μF ±10%.           C73         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C82         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C83         Tantalum: 1 μF ±20% 16 VDCW,           C84         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C88         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C90         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4.7 μF ±10% 16 VDCW,           C92         Electrolytic: 33 μF ±10% 25 VDCW,           C93         Mica: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C94         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C95         Electrolytic: 33 μF ±10% 25 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C98         Ceramic: 100 pF ±5% 50 VDCW, (Used in HC).           Mica: 20 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C99         Ceramic: 300 pF ±5% 50 VDCW, (Used in LA, LB, LC).           Cph         Ceramic: 100 pF ±5% 50 VDCW, (Used in LA	C67			
0±30 PPM (Used in HA,HB,HC).           C71         Tantalum: 10 μF ±20%,35 VDCW (Used in HA,HB,HC).           C71         Tantalum: 10 μF ±20% 16 VDCW (Used in LA,LB,LC).           C72         Electrolytic: 10 μF ±10%.           C73         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C82         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C83         Tantalum: 1 μF ±20% 16 VDCW,           C84         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C88         C89           C89         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C90         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4.7 μF ±10% 16 VDCW,           C92         Electrolytic: 100 μF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 50 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 500 VDCW (Used in HC).           C98         Mica: 30 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C99         Ceramic: 330 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).	C68			
C71         Tantalum: 10 μF ±20%,35 VDCW (Used in HA,HB,HC).           C71         Tantalum: 10 μF ±20% 16 VDCW (Used in LA,LB,LC).           C72         Electrolytic: 10 μF ±10%.           C73         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM. (Used in HA,HB,HC).           C82         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C83         Tantalum: 1 μF ±20% 16 VDCW,           C84         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C88         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C90         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4.7 μF ±10% 16 VDCW,           C92         Electrolytic: 100 μF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 50 VDCW,           C94         Electrolytic: 33 μF ±10% 25 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           Mica: 29 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C99         Ceramic: 330 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C01         Silicon: fwd current 3A, 200 PIV; sim to MOTOROLA MR751 (Used in HA,HB,HC).           CD2         Cerami	C69			
C71  Tantalum: 10 μF ±20% 16 VDCW (Used in LA,LB,LC).  C72  Electrolytic: 10 μF ±10%.  Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).  C82  Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.  C83  Tantalum: 1 μF ±20% 16 VDCW, temp coef 0±30 PPM.  C84  Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.  C88  C89  Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.  C89  Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.  C90  Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).  C91  Tantalum: 4.7 μF ±10% 16 VDCW,  C92  Electrolytic: 100 μF ±20% 50 VDCW,  C93  Mica: 100 pF ±5% 500 VDCW,  C95  Electrolytic: 33 μF ±10% 25 VDCW,  Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).  C97  Mica: 22 pF ±5% 100 VDCW (Used in HC).  Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).  C99  Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).  C151*  Ceramic: 300 pF ±5% 50 VDCW, (Used in LA,LB,LC).  C151*  Ceramic: 300 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).  C151*  Ceramic: 300 pF ±5% 50 VDCW, Used in LA,LB,LC).  Diode: sim to PANASONIC MA741-TX.  Diode: sim to PANASONIC MA741-TX.  Diode: sim to PANASONIC MA741-TX.  Diode: Used in HA,HB,HC).  Diode.  Diode (Used in HA,HB,HC).  Diode.  Diode (Used in HA,HB,HC).  Diode.  Diode (Used in HA,HB,HC).	C71		Tantalum: 10 μF ±20%,35 VDCW (Used in	
C73         Ceramic: 100 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C82         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C83         Tantalum: 1 μF ±20% 16 VDCW,           C84 thru         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C88         Ceramic: 0.1 μF ±5% 25 VDCW,           C90         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4.7 μF ±10% 16 VDCW,           C92         Electrolytic: 100 μF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 500 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           Mica: 90 pF ±5% 500 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW, (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW, (Used in LA,LB,LC).           CD2         Ceramic: Varistor; sim to HOKURIKU 22ZR-10D.           CD3         Diode: Sim to PANASONIC MA741-TX.           CD4         Diode: Gused in HA,HB,HC).           CD5         Diode (Used in HA,HB,HC).           CD6         Diode (Used in HA,HB,HC).           Diode         Cused in HA,HB,HC). <td>C71</td> <td></td> <td>Tantalum: 10 μF ±20% 16 VDCW (Used in</td>	C71		Tantalum: 10 μF ±20% 16 VDCW (Used in	
C82         O±60 PPM (Used in HA,HB,HC).           C83         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C84         Tantalum: 1 μF ±20% 16 VDCW,           C87         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C88         Ceramic: 0.1 μF ±5% 25 VDCW,           C90         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4.7 μF ±10% 16 VDCW,           C92         Electrolytic: 100 μF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 500 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           C98         Mica: 90 pF ±5% 500 VDCW (Used in HC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW, (Used in LA,LB,LC).           CD1         Silicon: fwd current 3A, 200 PIV; sim to MOTOROLA MR751 (Used in HA,HB,HC).           CD2         Ceramic: Varistor; sim to HOKURIKU 22ZR-10D.           CD3         Diode: sim to PANASONIC MA741-TX.           CD4         Diode (Used in HA,HB,HC).           CD5         Diode (Used in HA,HB,HC).           CD6         Diode (Us	C72		Electrolytic: 10 μF ±10%.	
C83         Tantalum: 1 μF ±20% 16 VDCW,           C84 thru         Ceramic: 100 pF ±5% 50 VDCW, temp coef           C88         C89           C89         Ceramic: 0.1 μF ±5% 25 VDCW,           C90         Ceramic: 100 pF ±5% 50 VDCW, temp coef           C91         Tantalum: 4.7 μF ±10% 16 VDCW,           C92         Electrolytic: 100 μF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 500 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           C98         Mica: 90 pF ±5% 500 VDCW (Used in HC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef           C151*         Ceramic: 330 pF ±5% 50 VDCW, Used in LA, LB, LC).           CD1         Silicon: fwd current 3A, 200 PIV; sim to MOTOROLA MR751 (Used in HA, HB, HC).           CD2         Ceramic: Varistor; sim to HOKURIKU 22ZR-10D.           CD3         Diode: sim to PANASONIC MA741-TX.           CD4         Diode (Used in HA, HB, HC).           CD5         Diode (Used in HA, HB, HC).           CD6         Diode (Used in HA, HB, HC).           CD6         Diode (Used in HA, HB, HC).	C73			
C84 thru         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM.           C88         Ceramic: 0.1 μF ±5% 25 VDCW,           C90         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4.7 μF ±10% 16 VDCW,           C92         Electrolytic: 100 μF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 500 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           C98         Mica: 90 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW, (Used in LA, LB, LC).           CD1         Silicon: fwd current 3A, 200 PIV; sim to MOTOROLA MR751 (Used in HA,HB,HC).           CD2         Ceramic: Varistor; sim to HOKURIKU 22ZR-10D.           CD3         Diode: sim to PANASONIC MA741-TX.           CD6         Diode (Used in HA,HB,HC).           CD7         Diode           CD8         Diode (Used in HA,HB,HC).           CD9         Diode.           CD10         Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L.           CD11	C82			
thru         0±30 PPM.           C88         Ceramic: 0.1 μF ±5% 25 VDCW,           C90         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4.7 μF ±10% 16 VDCW,           C92         Electrolytic: 100 μF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 500 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           C98         Mica: 90 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW, (Used in LA, LB, LC).           CD1         Silicon: fwd current 3A, 200 PIV; sim to MOTOROLA MR751 (Used in HA,HB,HC).           CD2         Ceramic: Varistor; sim to HOKURIKU 22ZR-10D.           CD3         Diode: sim to PANASONIC MA741-TX.           CD5         Diode (Used in LA,LB,LC).           CD6         Diode (Used in HA,HB,HC).           CD7         Diode           CD8         Diode (Used in HA,HB,HC).           CD9         Diode.           CD10         Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L.	C83		Tantalum: 1 $\mu$ F $\pm$ 20% 16 VDCW,	
C89         Ceramic: 0.1 μF ±5% 25 VDCW,           C90         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in HA,HB,HC).           C91         Tantalum: 4.7 μF ±10% 16 VDCW,           C92         Electrolytic: 100 μF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 500 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           C98         Mica: 90 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW, (Used in LA, LB, LC).           CD1         Silicon: fwd current 3A, 200 PIV; sim to MOTOROLA MR751 (Used in HA,HB,HC).           CD2         Ceramic: Varistor; sim to HOKURIKU 22ZR-10D.           CD3         Diode: sim to PANASONIC MA741-TX.           CD4         Diode: sim to PANASONIC MA741-TX.           CD5         Diode (Used in HA,HB,HC).           CD6         Diode (Used in HA,HB,HC).           CD7         Diode           CD8         Diode (Used in HA,HB,HC).           CD9         Diode.           CD10         Silicon: fast recovery (2 diodes in cathode common); sim to TOSH	thru			
C91         O±30 PPM (Used in HA,HB,HC).           C92         Tantalum: 4.7 μF ±10% 16 VDCW,           C93         Mica: 100 μF ±20% 50 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           C98         Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW, (Used in LA, LB, LC, HA, HB).           ————————————————————————————————————			Ceramic: 0.1 μF ±5% 25 VDCW,	
C92         Electrolytic: 100 μF ±20% 50 VDCW,           C93         Mica: 100 pF ±5% 500 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           C98         Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW,(Used in LA, LB, LC).           CD1         Silicon: fwd current 3A, 200 PIV; sim to MOTOROLA MR751 (Used in HA,HB,HC).           CD2         Ceramic: Varistor; sim to HOKURIKU 22ZR-10D.           CD3         Diode: sim to PANASONIC MA741-TX.           CD4         Diode (Used in LA,LB,LC).           CD5         Diode (Used in HA,HB,HC).           CD6         Diode (Used in HA,HB,HC).           CD7         Diode           CD8         Diode (Used in HA,HB,HC).           CD9         Diode           CD10         Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L.           CD11         Silicon: fast recovery, (RF Switch); sim to	C90			
C93         Mica: 100 pF ±5% 500 VDCW,           C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           C98         Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW,(Used in LA, LB, LC, HA, HB).           ————————————————————————————————————	C91		Tantalum: 4.7 μF ±10% 16 VDCW,	
C95         Electrolytic: 33 μF ±10% 25 VDCW,           C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           C98         Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW,(Used in LA, LB, LC).           CD1         Silicon: fwd current 3A, 200 PIV; sim to MOTOROLA MR751 (Used in HA,HB,HC).           CD2         Ceramic: Varistor; sim to HOKURIKU 22ZR-10D.           CD3         Diode: sim to PANASONIC MA741-TX.           CD4         Diode (Used in LA,LB,LC).           CD5         Diode (Used in HA,HB,HC).           CD6         Diode (Used in HA,HB,HC).           CD7         Diode.           CD8         Diode (Used in HA,HB,HC).           CD9         Diode.           CD10         Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L.           CD11         Silicon: fast recovery, (RF Switch); sim to	C92		Electrolytic: 100 μF ±20% 50 VDCW,	
C96         Ceramic: 15 pF ±5% 500 VDCW, temp coef 0±60 PPM (Used in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           C98         Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW,(Used in LA, LB, LC, HA, HB).           ————————————————————————————————————	C93		Mica: 100 pF ±5% 500 VDCW,	
0±60 PPM (Üsed in HA,HB,HC).           C97         Mica: 22 pF ±5% 100 VDCW (Used in HC).           C98         Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW,(Used in LA, LB, LC, HA, HB).           ————————————————————————————————————	C95		Electrolytic: 33 $\mu$ F ±10% 25 VDCW,	
C98         Mica: 90 pF ±5% 500 VDCW (Used in HA,HB,HC).           C99         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW,(Used in LA, LB, LC, HA, HB).           ————————————————————————————————————	C96			
C99       HA,HB,HC).         Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM (Used in LA,LB,LC).         C151*       Ceramic: 330 pF ±5% 50 VDCW,(Used in LA, LB, LC, HA, HB).         ————————————————————————————————————	C97		, , ,	
0±30 PPM (Used in LA,LB,LC).           C151*         Ceramic: 330 pF ±5% 50 VDCW,(Used in LA, LB, LC, HA, HB).           ————————————————————————————————————	C98			
LB, LC, HA, HB).	C99		0±30 PPM (Used in LA,LB,LC).	
CD1  Silicon: fwd current 3A, 200 PIV; sim to MOTOROLA MR751 (Used in HA,HB,HC).  CD2  Ceramic: Varistor; sim to HOKURIKU 22ZR-10D.  Diode: sim to PANASONIC MA741-TX.  Diode: (Used in LA,LB,LC).  Diode (Used in HA,HB,HC).  Diode (Used in HA,HB,HC).  Diode (Used in HA,HB,HC).  Diode (Used in HA,HB,HC).  CD9  Diode.  CD10  Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L.  CD11  Silicon: fast recovery, (RF Switch); sim to	C151*		LB, LC, HA, HB) .	
MOTOROLA MR751 (Üsed in HA,HB,HC).  CD2  Ceramic: Varistor; sim to HOKURIKU 22ZR- 10D.  Diode: sim to PANASONIC MA741-TX.  Diode: sim to PANASONIC MA741-TX.  Diode. (Used in LA,LB,LC).  Diode (Used in HA,HB,HC).  Diode.  CD7  Diode.  CD8  Diode (Used in HA,HB,HC).  Diode.  CD9  Diode.  CD10  Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L.  CD11  Silicon: fast recovery, (RF Switch); sim to				
10D.  CD3 and CD4  CD5  Diode: sim to PANASONIC MA741-TX.  Diode. (Used in LA,LB,LC).  CD6  Diode (Used in HA,HB,HC).  Diode.  CD7  Diode.  CD8  Diode (Used in HA,HB,HC).  Diode.  CD9  CD10  Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L.  CD11  Silicon: fast recovery, (RF Switch); sim to			MOTOROLA MR751 (Used in HA,HB,HC).	
and CD4 CD5 Diode.(Used in LA,LB,LC). CD6 Diode (Used in HA,HB,HC). CD7 Diode. CD8 Diode (Used in HA,HB,HC). CD9 Diode. CD9 CD10 Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L. CD11 Silicon: fast recovery, (RF Switch); sim to			10D.	
CD5 CD6 Diode.(Used in LA,LB,LC). Diode (Used in HA,HB,HC). CD7 Diode. CD8 Diode (Used in HA,HB,HC). CD9 Diode. CD10 Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L. CD11 Silicon: fast recovery, (RF Switch); sim to	and		Diode: sim to PANASONIC MA741-TX.	
CD7 CD8 Diode. CD9 Diode (Used in HA,HB,HC). Diode. CD10 Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L. CD11 Silicon: fast recovery, (RF Switch); sim to			Diode.(Used in LA,LB,LC).	
CD8 CD9 Diode (Used in HA,HB,HC). Diode. CD10 Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L. CD11 Silicon: fast recovery, (RF Switch); sim to	CD6		Diode (Used in HA,HB,HC).	
CD9 Diode. CD10 Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L. CD11 Silicon: fast recovery, (RF Switch); sim to	CD7		Diode.	
CD10 Silicon: fast recovery (2 diodes in cathode common); sim to TOSHIBA 1SS184 TE85L.  CD11 Silicon: fast recovery, (RF Switch); sim to	CD8		Diode (Used in HA,HB,HC).	
common); sim to TÓSHIBA 1SS184 TE85L. CD11 Silicon: fast recovery, (RF Switch); sim to				
			common); sim to TOSHIBA 1SS184 TE85L.	
CD12	and			

HC1	SYMBOL	PART NO.	DESCRIPTION	
HC1	011111202	17.11.11.0.		
HC1	HC1		RF Power Amplifier: sim to MITSUBISHI	
HC1	HC1		RF Power Amplifier: sim to MITSUBISHI	
IC1	HC1		RF Power Amplifier: sim to MITSUBISHI	
Linear, Dual OP Amp: sim to NEW JRC NJM3404AM.	IC1		Linear: Positive Voltage Regulator; sim to	
Connector.   Coil.	IC2		PANASONIC AN6541. Linear, Dual OP Amp: sim to NEW JRC	
L1 Coil. L2 Coil (Used in LA,HA,HB). L2 Coil (Used in LB,LC,HC). L3 Coil. L4 Coil. L6 Coil (Used in HA,HB,HC). L6 Coil (Used in HA,HB,HC). L6 Coil (Used in HA,HB,HC). L7 Coil (Used in HA,HB,HC). L8 Coil (Used in HA,HB,HC). L9 Coil (Used in HA,HB,HC). L10 Coil (Used in HA,HB,HC). L11 Coil (Used in HA,HB,HC). L12 Coil (Used in HA,HB,HC). L13 Coil (Used in HA,HB,HC). L14 Coil (Used in HA,HB,HC). L15 Coil (Used in HA,HB,HC). L16 Coil. L17 Coil (Used in HA,HB,HC). Coil (Used in HA,HB,HC). Coil (Used in HA,HB,HC). Coil (Used in HA,HB,HC). Coil. Coil. Coil. Coil. Coil. Coil. Coil. Coil (Used in HA,HB,HC). Coaxial cable with connector (Used in LA,LB,LC). P2 Coaxial cable with connector (Used in LA,LB,LC).	J3		Connector.	
L1 L2 Coil. Coil (Used in LA,HA,HB). L2 Coil (Used in LB,LC,HC). Coil. Coil. Coil. Coil. L4 Coil. L6 Coil (Used in HA,HB,HC). L6 Coil (Used in LB,LC). Coil. L7 Coil.(Used in LB,LC). L7 Coil.(Used in HA,HB,HC). L8 Coil (Used in HA,HB,HC). L9 Coil (Used in HA,HB,HC). Coil. Coi	J4		Connector.	
L1 L2 Coil. Coil (Used in LA,HA,HB). L2 Coil (Used in LB,LC,HC). Coil. Coil. Coil. Coil. L4 Coil. L6 Coil (Used in HA,HB,HC). L6 Coil (Used in LB,LC). Coil. L7 Coil.(Used in LB,LC). L7 Coil.(Used in HA,HB,HC). L8 Coil (Used in HA,HB,HC). L9 Coil (Used in HA,HB,HC). Coil. Coi				
L2				
L2 L3 Coil (Used in LB,LC,HC). Coil. L4 Coil. L6 Coil (Used in HA,HB,HC). Coil (Used in LA). L6 Coil (Used in LA). L6 Coil (Used in LA). L6 Coil (Used in HA,HB,HC). L7 Coil (Used in HA,HB,HC). L9 Coil (Used in HA,HB,HC). L10 Coil (Used in HA,HB,HC). Coil. Coil. Coil. Coil. Coil. Coil (Used in HA,HB,HC). Coil (Used in LA,LB,LC,). Coil (Used in HA,HB,HC). Coil (Used in HA,HB,HC). Coaxial cable with connector (Used in LA,LB,LC).				
L3 L4 Coil. Coil. Coil (Used in HA,HB,HC). L6 Coil (Used in LB,LC). L7 Coil.(Used in HA,HB,HC). L8 Coil (Used in HA,HB,HC). L9 Coil (Used in HA,HB,HC). L10 Coil (Used in HA,HB,HC). L11 Coil (Used in HA,HB,HC). L12 Coil (Used in HA,HB,HC). L13 Coil (Used in HA,HB,HC). L14 Coil (Used in HA,HB,HC). L15 Coil (Used in HA,HB,HC). L16 Coil. L17 Coil. L18 Coil. L19 Coil (Used in HA,HB,HC). Coil. Coil. L19 Coil (Used in HA,HB,HC). Coil (Used in HA,HB,HC). Coil.				
L4			, , ,	
L6 L6 L6 Coil (Used in HA,HB,HC). L6 Coil (Used in LA). L6 Coil (Used in LB,LC). L7 Coil.(Used in HA,HB,HC). L8 Coil (Used in HA,HB,HC). L9 L10 L10 Coil (Used in HA,HB,HC). L11 Coil (Used in HA,HB,HC). L12 Coil (Used in HA,HB,HC). L13 Coil (Used in HA,HB,HC). L14 Coil (Used in HA,HB,HC). L15 Coil (Used in HA,HB,HC). L16 Coil. L17 Coil. L18 Coil. L19 Coil (Used in HA,HB,HC). Coil (Used in HA,HB,HC). Coil (Used in HA,HB,HC). Coil. L19 Coil (Used in HA,HB,HC). Coil (Used in HA,HB,HC). Coil (Used in LA,LB,LC). Coil. L20 and L21 L22 Coil. Coil. Coil (Used in HA,HB).  Coil (Used in HA,HB,LC). Coil (Used in HA,HB,HC). Coil (Used in HA,HB,HC). Coaxial cable with connector (Used in HA,HB,HC).  Coaxial cable with connector (Used in HA,HB,HC).  Coaxial cable with connector (Used in LA,LB,LC). P2 Coaxial cable with connector (Used in LA,LB,LC). Coaxial cable with connector (Used in LA,LB,LC). P2 Coaxial cable with connector (Used in LA,LB,LC). Coaxial cable with connector (Used in LA,LB,LC). P2 Coaxial cable with connector (Used in LA,LB,LC). Coaxial cable with connector (Used in LA,LB,LC).	-			
Coil (Used in LA).				
L6         Coil (Used in LB,LC).           L7         Coil. (Used in HA,HB,HC).           L8         Coil (Used in HA,HB,HC).           L9         Coil (Used in HA,HB,HC).           L10         Coil (Used in HA,HB,HC).           L11         Coil (Used in HA,HB,HC).           L12         Coil (Used in HA,HB,HC).           L13         Coil (Used in HA,HB,HC).           L14         Coil (Used in HA,HB,HC).           L15         Coil.           L17         Coil.           L18         Coil.           L19         Coil (Used in HA,HB,HC).           L19         Coil (Used in LA,LB,LC).           L20         and           L21         Coil.           L22         Coil.           L23         Coil (Used in HA,HB).           L24         Coil (Used in HA,LB,LC).           L23         Coil (Used in LA,LB,LC,).           L24         Coil (Used in LA,LB,LC).           L25         Coil (Used in HA,HB,HC).           Coaxial cable with connector (Used in LA,LB,LC).           P1         Coaxial cable with connector (Used in HA,HB,HC).           Coaxial cable with connector (Used in LA,LB,LC).           Coaxial cable with connector (Used in LA,LB,LC). <td>-</td> <td></td> <td>, , ,</td>	-		, , ,	
L7       Coil.(Used in HA,HB,HC).         L8       Coil (Used in HA,HB,HC).         L9       Coil (Used in HA,HB,HC).         L10       Coil (Used in HA,HB,HC).         L11       Coil (Used in HA,HB,HC).         L12       Coil (Used in HA,HB,HC).         L13       Coil (Used in HA,HB,HC).         L14       Coil (Used in HA,HB,HC).         L15       Coil. (Used in HA,HB,HC).         L16       Coil.         L17       Coil.         L18       Coil (Used in HA,HB,HC).         L19       Coil (Used in LA,LB,LC).         L20       and         L21       Coil.         L22       Coil.         L23       Coil (Used in HA,HB).         L24       Coil (Used in HA,LB,LC,).         Coil (Used in LA,LB,LC,).       Coil (Used in LA,LB,LC,).         Coil (Used in HA,HB,HC).       Coaxial cable with connector (Used in LA,LB,LC).         P1       Coaxial cable with connector (Used in LA,LB,LC).         P2       Coaxial cable with connector (Used in LA,LB,LC).         P2       Coaxial cable with connector (Used in LA,LB,LC).	-		,	
Coil (Used in HA,HB,HC).			, ,	
L9         Coil (Used in HA,HB,HC).           L10         Coil (Used in HA,HB,HC).           L11         Coil (Used in HA,HB,HC).           L12         Coil (Used in HA,HB,HC).           L13         Coil (Used in HA,HB,HC).           L14         Coil (Used in HA,HB,HC).           L15         Coil. (Used in HA,HB,HC).           L16         Coil.           L17         Coil.           L18         Coil.           L19         Coil (Used in HA,HB,HC).           L19         Coil (Used in LA,LB,LC).           L20         and           L21         Coil.           L22         Coil.           L23         Coil (Used in HA,HB).           Coil (Used in HC).         Coil (Used in LA,LB,LC,).           Coil (Used in LA,LB,LC,).         Coil (Used in HA,HB,HC).           P1         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           Coaxial cable with connector (Used in LA,LB,LC).			, , ,	
L10         Coil (Used in HA,HB,HC).           L11         Coil (Used in HA,HB,HC).           L12         Coil (Used in HA,HB,HC).           L13         Coil (Used in HA,HB,HC).           L14         Coil (Used in HA,HB,HC).           L15         Coil (Used in HA,HB,HC).           L16         Coil.           L17         Coil.           L18         Coil (Used in HA,HB,HC).           L19         Coil (Used in LA,LB,LC).           L20         Coil.           and         L21           L22         Coil.           Coil (Used in HA,HB).           L24         Coil (Used in HC).           Coil (Used in LA,LB,LC,).           Coil (Used in HA,HB,HC).           P1         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).	_		•	
L11         Coil (Used in HA,HB,HC).           L12         Coil (Used in HA,HB,HC).           L13         Coil (Used in HA,HB,HC).           L14         Coil (Used in HA,HB,HC).           L15         Coil (Used in HA,HB,HC).           L16         Coil.           L17         Coil.           L18         Coil (Used in HA,HB,HC).           L19         Coil (Used in LA,LB,LC).           L20         Coil.           Coil.         Coil.           L22         Coil.           L23         Coil (Used in HA,HB).           Coil (Used in HC).         Coil (Used in LA,LB,LC,).           Coil (Used in LA,LB,LC,).         Coil (Used in HA,HB,HC).           P1         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).	-		, , , , , , , , , , , , , , , , , , , ,	
L12         Coil (Used in HA,HB,HC).           L13         Coil (Used in HA,HB,HC).           L14         Coil (Used in HA,HB,HC).           L15         Coil (Used in HA,HB,HC).           L16         Coil.           L17         Coil.           L18         Coil (Used in HA,HB,HC).           L19         Coil (Used in LA,LB,LC).           L20         Coil.           and         L21           L22         Coil.           Coil (Used in HA,HB).           L24         Coil (Used in HC).           L23         Coil (Used in LA,LB,LC,).           L24         Coil (Used in LA,LB,LC,).           Coil (Used in HA,HB,HC).         Coaxial cable with connector (Used in LA,LB,LC).           P1         Coaxial cable with connector (Used in HA,HB,HC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).	_		, , ,	
L13         Coil (Used in HA,HB,HC).           L14         Coil (Used in HA,HB,HC).           L15         Coil (Used in HA,HB,HC).           L16         Coil.           L17         Coil.           L18         Coil (Used in HA,HB,HC).           L19         Coil (Used in LA,LB,LC).           L20         and L21           L21         Coil.           L22         Coil.           L23         Coil (Used in HA,HB).           L24         Coil (Used in HC).           L23         Coil (Used in LA,LB,LC,).           L24         Coil (Used in LA,LB,LC,).           Coil (Used in HA,HB,HC).         Coaxial cable with connector (Used in LA,LB,LC).           P1         Coaxial cable with connector (Used in HA,HB,HC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).			, , ,	
L14       Coil (Used in HA,HB,HC).         L15       Coil (Used in HA,HB,HC).         L16       Coil.         L17       Coil.         L18       Coil.         L19       Coil (Used in HA,HB,HC).         L19       Coil (Used in LA,LB,LC).         L20       and         L21       Coil.         L22       Coil.         L23       Coil (Used in HA,HB).         and       L24         L23       Coil (Used in LA,LB,LC,).         L24       Coil (Used in LA,LB,LC,).         Coil (Used in HA,HB,HC).       Coaxial cable with connector (Used in LA,LB,LC).         P1       Coaxial cable with connector (Used in HA,HB,HC).         P2       Coaxial cable with connector (Used in LA,LB,LC).         P2       Coaxial cable with connector (Used in LA,LB,LC).         P2       Coaxial cable with connector (Used in LA,LB,LC).			, , ,	
L15         Coil (Used in HA,HB,HC).           L16         Coil.           L17         Coil.           L18         Coil (Used in HA,HB,HC).           L19         Coil (Used in LA,LB,LC).           L20         and           L21         Coil.           L22         Coil.           L23         Coil (Used in HA,HB).           and         L24           L23         Coil (Used in HC).           and         L24           L23         Coil (Used in LA,LB,LC,).           Coil (Used in HA,HB,HC).         Coil (Used in HA,HB,HC).           P1         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).	_		, , , , , , , , , , , , , , , , , , , ,	
L16         Coil.           L17         Coil.           L18         Coil.           L19         Coil (Used in HA,HB,HC).           L20         Coil.           and         L21           L22         Coil.           L23         Coil (Used in HA,HB).           and         L24           L23         Coil (Used in HC).           and         L24           L23         Coil (Used in LA,LB,LC,).           Coil (Used in HA,HB,HC).         Coil (Used in HA,HB,HC).           P1         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).			, , ,	
L17         Coil.           L18         Coil.           L19         Coil (Used in HA,HB,HC).           L20         Coil.           and         L21           L22         Coil.           L23         Coil (Used in HA,HB).           and         L24           L23         Coil (Used in HC).           and         L24           L23         Coil (Used in LA,LB,LC,).           Coil (Used in HA,HB,HC).         Coil (Used in HA,HB,HC).           P1         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).           P2         Coaxial cable with connector (Used in LA,LB,LC).	_		, , , , , , , , , , , , , , , , , , , ,	
L18 L19 Coil. Coil (Used in HA,HB,HC). L19 Coil (Used in LA,LB,LC). Coil. L20 and L21 L22 Coil. Coil. Coil. Coil. L23 and L24 L23 Coil (Used in HA,HB). Coil (Used in HC). Coil (Used in LA,LB,LC,). Coil (Used in LA,LB,LC,). Coil (Used in LA,LB,LC,). Coil (Used in HA,HB,HC). P1 Coaxial cable with connector (Used in LA,LB,LC). P2 Coaxial cable with connector (Used in LA,LB,LC).	_			
L19 L19 Coil (Used in HA,HB,HC). L20 and L21 L22 Coil.  Coil.  Coil (Used in HA,HB).  Coil (Used in HA,HB).  Coil (Used in HA,HB).  Coil (Used in HC).  Coil (Used in LA,LB,LC).  Coil (Used in LA,LB,LC,).  Coil (Used in LA,LB,LC,).  Coil (Used in HA,HB,HC).  P1 Coaxial cable with connector (Used in HA,HB,HC).  P2 Coaxial cable with connector (Used in LA,LB,LC).				
L19 L20 and L21 L22 Coil.  Coi	_			
L20 and L21 L22 Coil.  Coil.  Coil (Used in HA,HB).  Coil (Used in HC).  Coil (Used in LA,LB,LC,).  Coil (Used in LA,LB,LC,).  Coil (Used in LA,LB,LC,).  Coil (Used in HA,HB,HC).  P1 Coaxial cable with connector (Used in LA,LB,LC).  P1 Coaxial cable with connector (Used in HA,HB,HC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  Coaxial cable with connector (Used in LA,LB,LC).  Coaxial cable with connector (Used in LA,LB,LC).	_		, , , , , , , , , , , , , , , , , , , ,	
and L21 L22 Coil. Coil (Used in HA,HB).  Coil (Used in HC).  Coil (Used in HC).  Coil (Used in LA,LB,LC,).  Coil (Used in LA,LB,LC,).  Coil (Used in LA,HB,HC).  P1 Coaxial cable with connector (Used in LA,LB,LC).  P1 Coaxial cable with connector (Used in HA,HB,HC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  Coaxial cable with connector (Used in LA,LB,LC).	_		, , , , ,	
L22 L23 and L24 L23 and L24 L23 and L24 L23 Coil (Used in HC).  Coil (Used in LA,LB,LC,). Coil (Used in LA,LB,LC,). Coil (Used in LA,LB,LC,). Coil (Used in HA,HB,HC). P1 Coaxial cable with connector (Used in LA,LB,LC). P2 Coaxial cable with connector (Used in LA,LB,LC). P2 Coaxial cable with connector (Used in LA,LB,LC).	and			
L23 and L24 L23 and L24 L23 and L24 L23 Coil (Used in HC).  Coil (Used in LA,LB,LC,). Coil (Used in LA,LB,LC,). Coil (Used in LA,LB,LC,). Coil (Used in HA,HB,HC). P1 Coaxial cable with connector (Used in LA,LB,LC). P1 Coaxial cable with connector (Used in HA,HB,HC). P2 Coaxial cable with connector (Used in LA,LB,LC). P2 Coaxial cable with connector (Used in LA,LB,LC). Coaxial cable with connector (Used in LA,LB,LC).			Cail	
and L24 L23 and L24 L23 Coil (Used in HC).  Coil (Used in LA,LB,LC,).  Coil (Used in LA,LB,LC,).  Coil (Used in LA,LB,LC,).  Coil (Used in HA,HB,HC).  P1 Coaxial cable with connector (Used in LA,LB,LC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  Coaxial cable with connector (Used in LA,LB,LC).				
and L24 L23 Coil (Used in LA,LB,LC,). L24 Coil (Used in LA,LB,LC,). Coil (Used in HA,HB,HC). P1 Coaxial cable with connector (Used in LA,LB,LC). P1 Coaxial cable with connector (Used in HA,HB,HC). P2 Coaxial cable with connector (Used in LA,LB,LC). P2 Coaxial cable with connector (Used in LA,LB,LC). P2 Coaxial cable with connector (Used in LA,LB,LC).	and		Coli (Osed III FIA,FIB).	
L23  Coil (Used in LA,LB,LC,).  Coil (Used in LA,LB,LC,).  Coil (Used in HA,HB,HC).  P1  Coaxial cable with connector (Used in LA,LB,LC).  P1  Coaxial cable with connector (Used in HA,HB,HC).  P2  Coaxial cable with connector (Used in LA,LB,LC).  P2  Coaxial cable with connector (Used in LA,LB,LC).  P2  Coaxial cable with connector (Used in LA,LB,LC).	and		Coil (Used in HC).	
L24 Coil (Used in LA,LB,LC,).  Coil (Used in HA,HB,HC).  Coaxial cable with connector (Used in LA,LB,LC).  P1 Coaxial cable with connector (Used in HA,HB,HC).  Coaxial cable with connector (Used in LA,LB,LC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  Coaxial cable with connector (Used in LA,LB,LC).				
L25 Coil (Used in HA,HB,HC).  Coaxial cable with connector (Used in LA,LB,LC).  P1 Coaxial cable with connector (Used in HA,HB,HC).  Coaxial cable with connector (Used in LA,LB,LC).  Coaxial cable with connector (Used in LA,LB,LC).  Coaxial cable with connector (Used in LA,LB,LC).			, , , , , , , , , , , , , , , , , , , ,	
P1 Coaxial cable with connector (Used in LA,LB,LC).  P1 Coaxial cable with connector (Used in HA,HB,HC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  P2 Coaxial cable with connector (Used in LA,LB,LC).			, , , , , , , , , , , , , , , , , , , ,	
LA,LB,LC).  P1 Coaxial cable with connector (Used in HA,HB,HC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  P2 Coaxial cable with connector (Used in LA,LB,LC).			, , ,	
HA,HB,HC).  P2 Coaxial cable with connector (Used in LA,LB,LC).  P2 Coaxial cable with connector (Used in	P1			
LA,LB,LC). P2 Coaxial cable with connector (Used in	P1			
	P2			
	P2			

SYMBOL	PART NO.	DESCRIPTION	
		RESISTORS	
R1		Metal film: 470 ohms $\pm$ 5%, 100 VDCW, 1/10W.	
R2 and R3		Metal film: 22 ohms $\pm$ 5%, 100 VDCW, 1/10W.	
R4		Metal film: 470 ohms ±5%, 100 VDCW, 1/10W.	
R5		Metal film: 24 ohms $\pm$ 5%, 350 VDCW, 3W (Used in HA,HB,HC,).	
R6 and R7		Metal film: 3.3K ohms ±5%, 250 VDCW, 1W (Used in HA,HB,HC).	
R8		Metal film: 24 ohms ±1%, 500 VDCW, 1.5W (Used in HA,HB,HC,).	
R10		Metal film: 82 ohms $\pm 5\%$ , 100 VDCW, 1/8W (Used in HA,HB,HC,).	
R10		Metal film: 68 ohms $\pm$ 5%, 100 VDCW, 1/10W (Used in LA,LB,LC,).	
R11		Metal film: 120 ohms $\pm$ 5%, 200 VDCW, 1/8W (Used in HA,HB,HC).	
R11 and R12		Metal film: 82 ohms ±5%, 100 VDCW, 1/10W (Used in LA,LB,LC,).	
R12 and R13		Metal film: 82 ohms ±5%, 200 VDCW, 1/8W (Used in HA,HB,HC).	
R13		Metal film: 68 ohms $\pm$ 5%, 100 VDCW, 1/10W (Used in LA,LB,LC,).	
R14		Metal film: 12k ohms $\pm 5\%$ , 100 VDCW, 1/10W (Used in HA).	
R14		Metal film: 18k ohms $\pm 5\%$ , 100 VDCW, 1/10W (Used in HB).	
R14		Metal film: 33k ohms $\pm$ 5%, 100 VDCW, 1/10W (Used in CH).	
R14		Metal film: 2.7 ohms $\pm 5\%$ , 100 VDCW, 1/10W (Used in LA,LB,LC,).	
R15		Metal film: 100 ohms $\pm$ 5%, 100 VDCW, 1/10W.	
R16		Metal film: 3.9K ohms $\pm$ 5%, 100 VDCW, 1/10W (Used in HA,HB).	
R16		Metal film: 4.7K ohms $\pm 5\%$ , 100 VDCW, 1/10W (Used in HC).	
R16		Metal film: 6.8K ohms ±5%, 100 VDCW, 1/10W (Used in LA,LB,LC).	
R17 and R18		Metal film: 120 ohms ±5%, 250 VDCW, 1W (Used in HA,HB,HC,).	
R17 and R18		Metal film: 180 ohms $\pm$ 5%, 250 VDCW, 1W (Used in LA,LB,LC).	
R19		Metal film: 47K ohms $\pm$ 5%, 200 VDCW, 1/4W.	
R20		Metal film: 4.7K ohms ±5%, 100 VDCW, 1/10W.	
R21		Metal film: 680 ohms ±5%, 200 VDCW, 1/4W.	
R35		Metal film: 10K ohms ±5%, 100 VDCW, 1/10W.	
R36		Metal film: 3.3K ohms $\pm$ 5%, 100 VDCW, 1/10W (Used in HA).	
R36		Metal film: 1.8K ohms $\pm$ 5%, 100 VDCW, 1/10W (Used in HB,HC).	
R36		Metal film: 2.2K ohms ±5%, 100 VDCW, 1/10W. (Used in LA,LB,LC).	
R37		Metal film: 2.2K ohms $\pm 5\%$ , 100 VDCW, 1/10W.	

SYMBOL	PART NO.	DESCRIPTION	
R38		Metal film: 10K ohms $\pm$ 5%, 100 VDCW, 1/10W, (Used in HA,HB,HC).	
R38		Metal film: 8.2K ohms ±5%, 100 VDCW, 1/10W (Used in LA,LB,LC).	
R39		Metal film: 2.7K ohms $\pm$ 5%, 100 VDCW, 1/10W (Used in HA,HB,HC).	
R39		Metal film: 3.9K ohms ±5%, 100 VDCW, 1/10W (Used in LA,LB,LC).	
R40		Metal film: 27K ohms $\pm$ 5%, 100 VDCW, 1/10W.	
R41		Metal film: 2.2K ohms $\pm 5\%$ , 100 VDCW, 1/10W.	
R42		Metal film: 47K ohms $\pm$ 5%, 100 VDCW, 1/10W.	
R43		Metal film: 1K ohms $\pm 5\%$ , 100 VDCW, 1/10W.	
R44 and R45		Metal film: 820 ohms $\pm 5\%$ , 100 VDCW, 1/10W.	
R46 and R47		Metal film: 470 ohms $\pm$ 5%, 100 VDCW, 1/10W.	
R48		Metal film: 10 ohms $\pm$ 5%, 200 VDCW, 1/8W.	
R49		Polyester: sim to MURATA PTH9M04BE222TS2F333.	
R50		Metal film: 100K ohms $\pm$ 5%, 100 VDCW, 1/10W.	
R52*		Metal film: 50 ohms, 10W (Used in LA, LB, LC, HA, HB) .	
RV1		Variable.	
		TRANSISTOR	
TR1		Silicon,NPN: sim to MITSUBISHI 2SC3102.	
TR2 and TR3		Silicon,NPN: sim to MITSUBISHI 2SC4989 (Used in HA,HB,HC).	
TR4		Silicon, PNP: sim to NEC 2SB624-T1B BV3.	
TR5 and TR6		Silicon, PNP: sim to NEC 2SB596-T1B DV3.	
TR7		Silicon PNP: sim to PANASONIC 2SB953A.	
TR8		Silicon NPN: sim to PANASONIC 2SD1271-Q.	
		WIRE	
W1		Jumper wire: (Used in HA,HB,HC).	
W3		Jumper wire: (Used in HA,HB,HC).	

#### PRODUCTION CHANGES

Changes in the equipment to improve or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number on the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for the description of parts affected by these revisions.

#### REV. A - Power Amplifier Units 344A4573P1 & P2

To improve stability. Deleted capacitor C6. Changed capacitor C45 to 4.7  $\mu\text{F}$ 

#### REV. A - Power Amplifier Units 344A4573P3, P4 & P5

To improve stability. Changed capacitor C12 from 36 pF to 47 Pf metal mica. This improves matching to the final amplifier.

#### REV. B- Power Amplifier Units 344A4573P3, P4 & P5

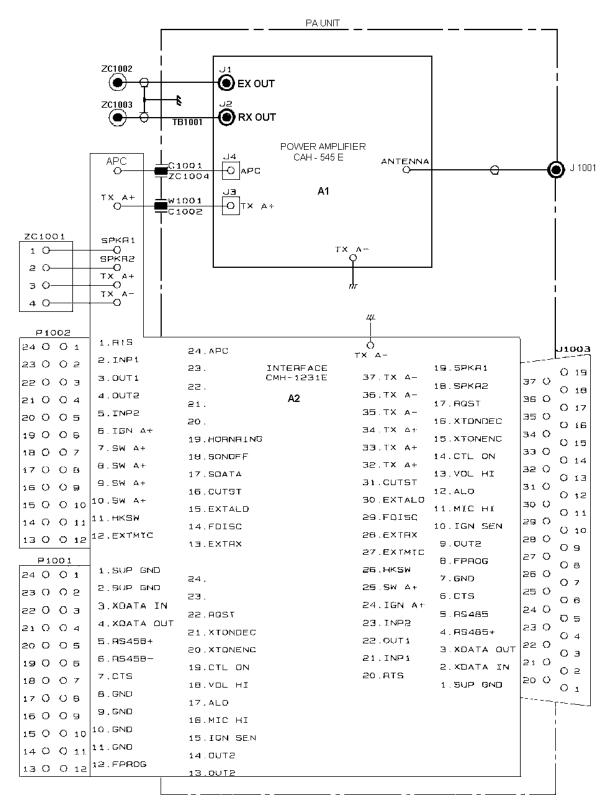
To improve PA stability. Added RC feedback to power amplifier transistor TR1 consisting of a 50-ohm resistor and a 330 pF capacitor.

#### REV. A - Power Amplifier Units 344A4573P6 & P7

To improve PA stability. Added RC feedback to power amplifier transistor TR1 consisting of a 50-ohm resistor and a 330 pF capacitor.

<u>P1001</u>

SUP GND SUP GND XDATAIN XDATAOUT



#### INTERCONNECTION DIAGRAM **EUROPEAN UHF PA UNIT**

(DD00-JHM-471PE)

## 1450000 678 0 4 XDATAGU 0 5 RS485+ 0 6 RS485-0 7 CTS 0 8 GND 0 9 GND 0 10 GND 0 11 GND 0 12 FPR06 0 13 GUT2 0 14 GUT2 0 15 IGN SEN FPROG QUT 2 ING SEN MIC HI ALO VOL HI GTL ON XTONENC XTONDEC CMH-1231U L/H INTERFACE A2 0 15 IGN SEN 0 16 MIC HI 0 17 ALO 0 18 VOL HI 0 19 CTL ON 0 20 XTONDEC 0 21 XTONDEC 0 22 RGST 0 29 ROST 17 ( SPKR1 18 ( SPKR2 19 ( INP1 21 0 0 11 22 0 1 1 22 0 1 1 22 0 1 23 0 1 24 0 24 0 25 0 1 25 0 0 25 0 1 2 INP1 21 ( 0 23 P1002 HST INP1 OUT1 OUT1 INP2 ING A+ SW A+ SW A+ 9 9 11 SEKAR SPKB1 HKSW O 12 EXTMIC O 14 FDISC O 15 EXTALO O 16 CUTST O 17 SDATA 0 17 SBATA 0 19 SONOFF 0 19 HORNRING 0 20 0 21 0 22 0 23 0 24 APC CAH-5451 /H J10<u>02</u> C1001 POWER AMPLIFIER C1004 本 +0 J1004 CD 1001 ZC1002 T× A+ O Z01003 T× A-Ex OUT J1001 ANTENNA P2 PX OUT

C1002: ONLY HIGH POWER UNIT CD1001: ONLY LOW POWER UNIT

SUP GND

RS485+ RS485-

CTS

MIATADX TUDATADX

### INTERCONNECTION DIAGRAM U.S.A. UHF PA UNIT

(DD00-JHM-471PL/H)

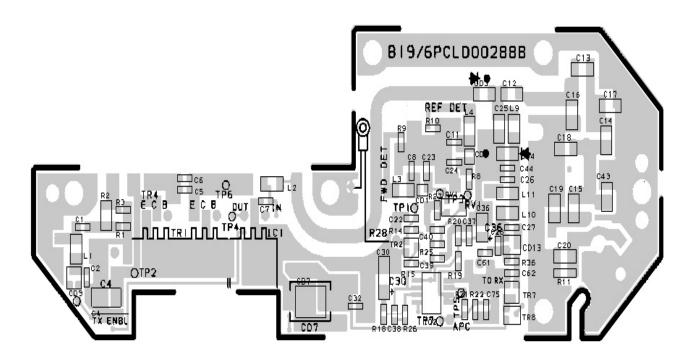
#### CAH-545LC **PART** CAH-545LA CAH-545LB 403-440 MHz 440-512 MHz 470-512 MHz (40W)(40W)(35W)12 pF 10 pF 10 pF C9 56 pF 56 pF 47 pF 47 pF C10 47 pF 36 pF C11 43 pF 33 pF 39 pF C12 36 pF 27 pF 12 pF 36 pF 39 pF 22 pF 10 pF C13 30 pF C41 12 pF C50 6 pF 6 pF 5 pF C58 3 pF 2 pF 2 pF C59 5 pF 3 pF 4 pF C60 6 pF 7 pF 6 pF C61 2 pF 1 pF 1 pF C64 5 pF 4 pF 3 pF C65 5 pF 4 pF 4 pF C66 4 pF 4 pF 3 pF C67 3pF 6LALD20855 6LALD20850 6LALD20850 6LALD20855 6LALD20850 6LALD20850 L6

(MADE FROM DD00-CAH-545L 2/2)

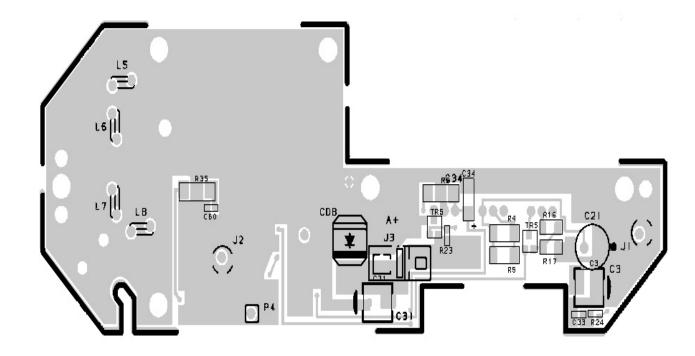
#### COMPONENT IDENTIFICATION CHART 403-512 MHz 80/100-Watt Power Amplifier

PART	САН-545НА	САН-545НВ	САН-545НС
	403-440 MHz (100W)	440-512 MHz (100W)	470-512 MHz (80W)
C7	12 pF	10 pF	10 pF
C9	56 pF	47 pF	47 pF
C10	56 pF	43 pF	36 pF
C11	43 pF	36 pF	33 pF
C12	43 pF	43 pF	33 pF
C13	30 pF	24 pF	-
C15	5 pF	5 pF	4 pF
C18	10 pF	9 pF	8 pF
C20	56 pF	47 pF	36 pF
C21	47 pF	39 pF	36 pF
C22	43 pF	36 pF	36 pF
C23	43 pF	43 pF	33 pF
C24	30 pF	27 pF	24 pF
C26	10 pF	10 pF	8 pF
C27	10 pF	9 pF	8 pF
C29	47 pF	39 pF	36 pF
C30	56 pF	47 pF	36 pF
C31	43 pF	43 pF	33 pF
C32	43 pF	36 pF	36 pF
C33	30 pF	27 pF	24 pF
C35	10 pF	10 pF	8 pF
C41	6 pF	8 pF	6 pF
C44	6 pF	5 pF	5 pF
C45	6 pF	5 pF	5 pF
C49	8 pF	7 pF	-
C50	-	-	4 pF
C56	3 pF	3 pF	4 pF
C57	7 pF	5 pF	6 pF
C58	3 pF	3 pF	2 pF
C59	3 pF	3 pF	2 pF
C60	3 pF	3 pF	4 pF
C61	2 pF	2 pF	1 pF
C62	7 pF	6 pF	6 pF
C63	4 pF	4 pF	3 pF
C64	3 pF	2 pF	1.5 pF
C65	6 pF	6 pF	4 pF
C66	-	7 pF	5 pF
C97	121-0	101-0	22 pF
R14	12kΩ	18kΩ	33kΩ 4.71-Ω
R16	3.9kΩ	3.9kΩ	4.7kΩ
R36	$3.3k\Omega$	$1.8k\Omega$	$1.8k\Omega$
L2	6LALD20855	6LALD20855	6LALD20855
L23 L24	6LALD12014	6LALD12014	6LALD12013
HC1	6LALD12014 M57704M-38	6LALD12014 M57704H-38	6LALD12013 M57704SH-38
пСІ	IVI3 / / U4IVI-38	WI3 / /U4H-38	WI3 / / U45H-38

(MADE FROM DD00-CAH-545H 2/2)



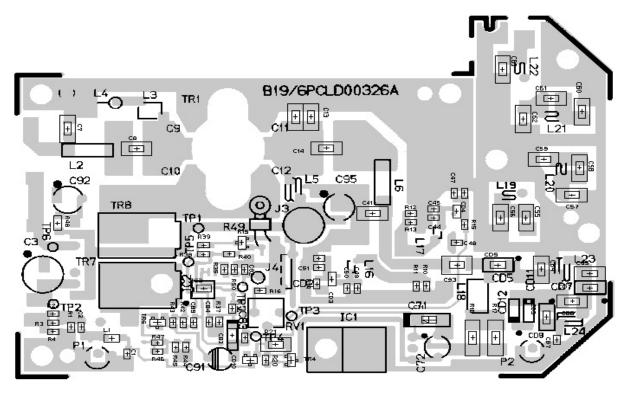
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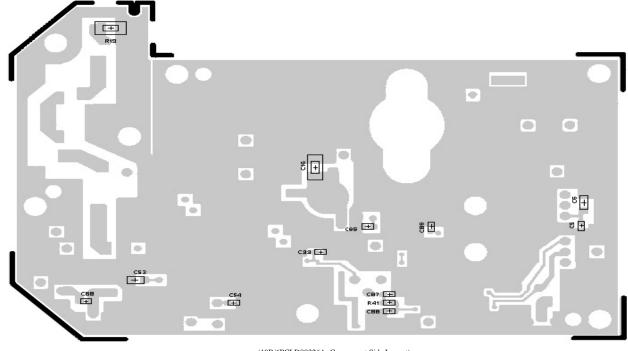
(B19/6PCLD00288B, Chip Components) (B19/6PCLD00288B, Solder Side 20-Watt Power Amplifier

CAH-545E

LBI-39034 OUTLINE DIAGRAM



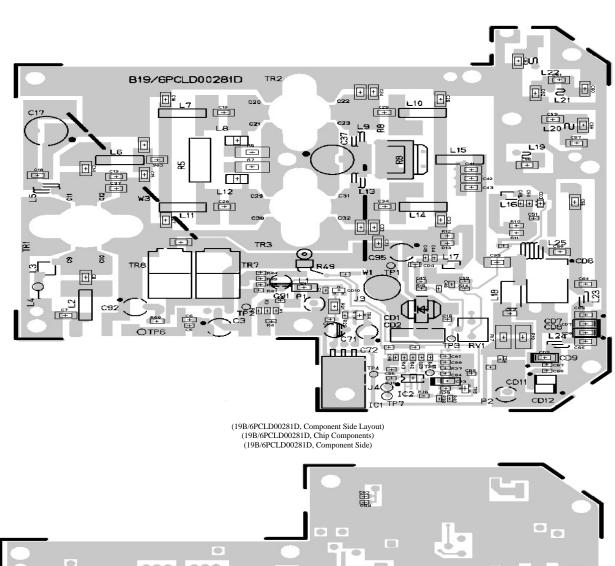
(19B/6PCLD00326A, Component Side Layout) (19B6PClD00326A, Chip Components) (19B6PLCD00326A, Component Side)

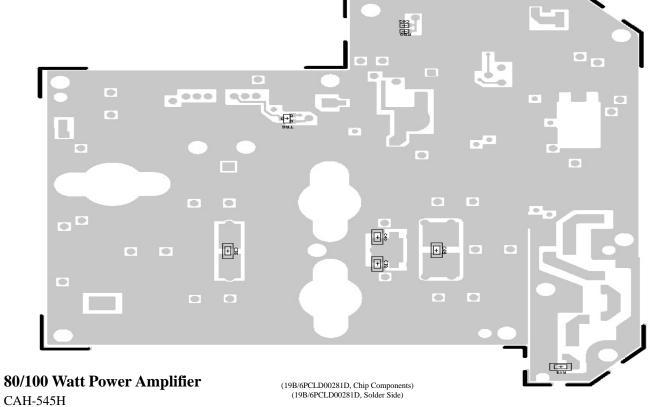


35/40 Watt Power Amplifier

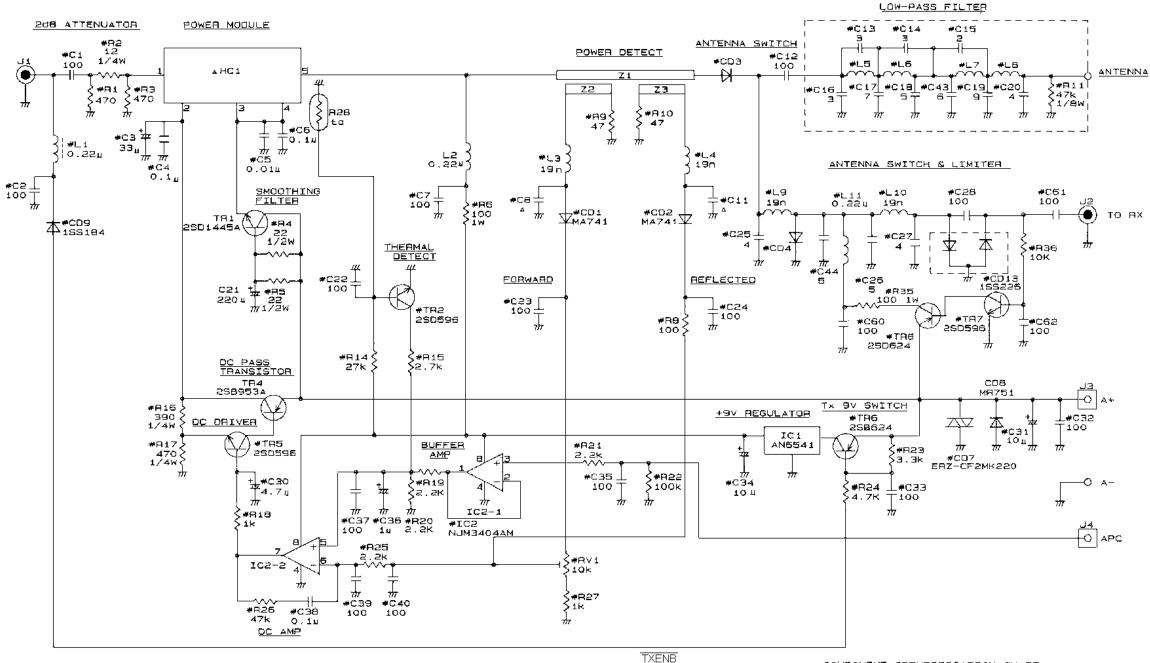
CAH-545L

(19B/6PCLD00326A, Component Side Layout)
(19B/6PCLD0032A, Chip Components)
(19B/6PCLD00326A, Solder Side)





SCHEMATIC DIAGRAM LBI-39034



1. "#" IDENTIFIES CHIP COMPONENTS (EXAMPLE #R12 OR R12#) WHICH ARE LOCATED ON THE COMPONENT SIDE OF THE BOARD.

2. Z1. Z2 AND Z3 ARE STRIPLINE PART OF PWB.

3. RV1 IS FACTORY TUNED AND DOES NOT REQUIRE FURTHER ADJUSTMENT.

ALL RESISTORS ARE 1/10 OR 1/8 WATT UNLESS OTHERWISE SPECIFIED. RESISTOR VALUES IN  $\Omega$  UNLESS FOLLOWED BY MULTIPLIER K OR M. CAPACITOR VALUES IN P UNLESS FOLLOWED BY MULTIPLIER µ. INDUCTANCE VALUES IN H UNLESS FOLLOWED BY MULTIPLIER m OR µ.

#### DC VOLTAGE READINGS

ALL VOLTAGES ARE TYPICAL, VOLTAGES ARE MEASURED WITH A 10Meg OHM PER VOLT METER. REFERENCE TO GROUND. VOLTAGE READINGS ARE TAKEN WITH THE TRANSMITTER UNKEYED/KEYED. EX .45 (UNKEYED)/.05 (KEYED).

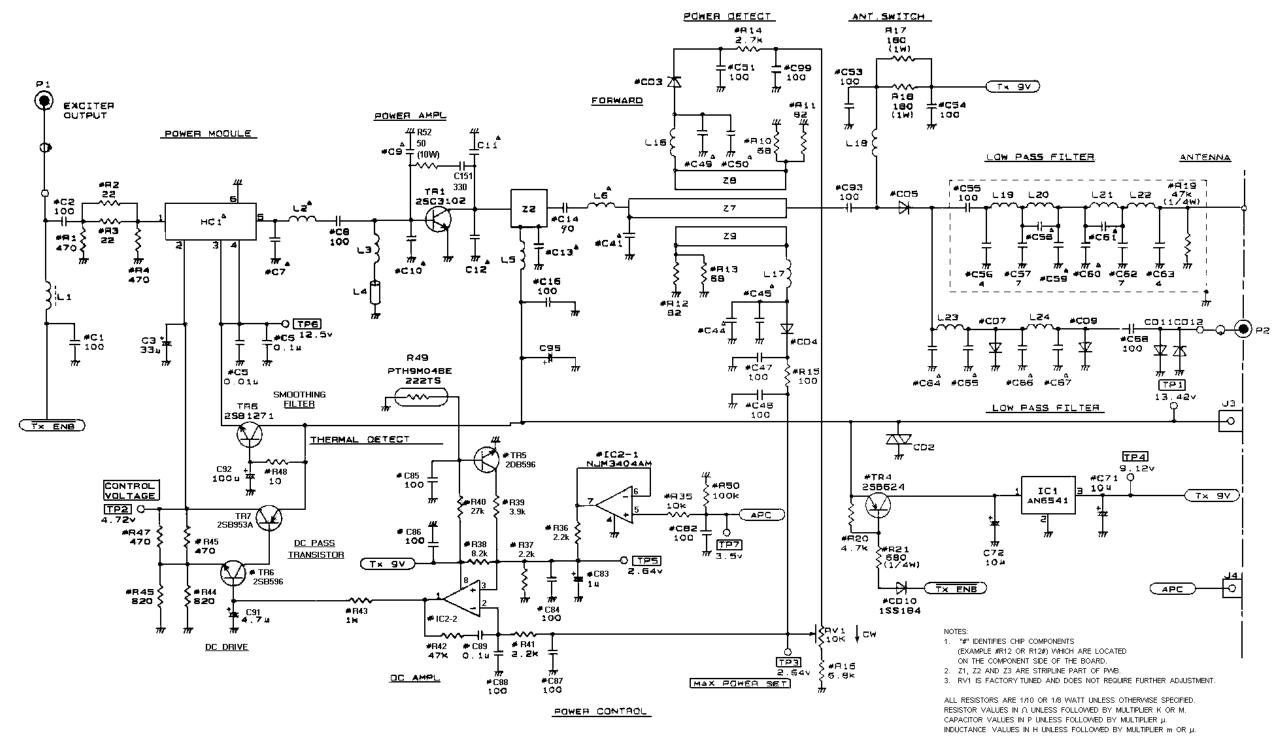
#### COMPONENT IDENTIFICATION CHART

PART	378-415 (MHz)	403-440 (MHz)	440 - 470 (MHz)
C8		7 <b>p</b> F	6pF
C11		7 <b>p</b> F	6pF
HC1	M57788SL-38	M57788L-38	M57788H-38

20 Watt Power Amplifier

CAH-545E

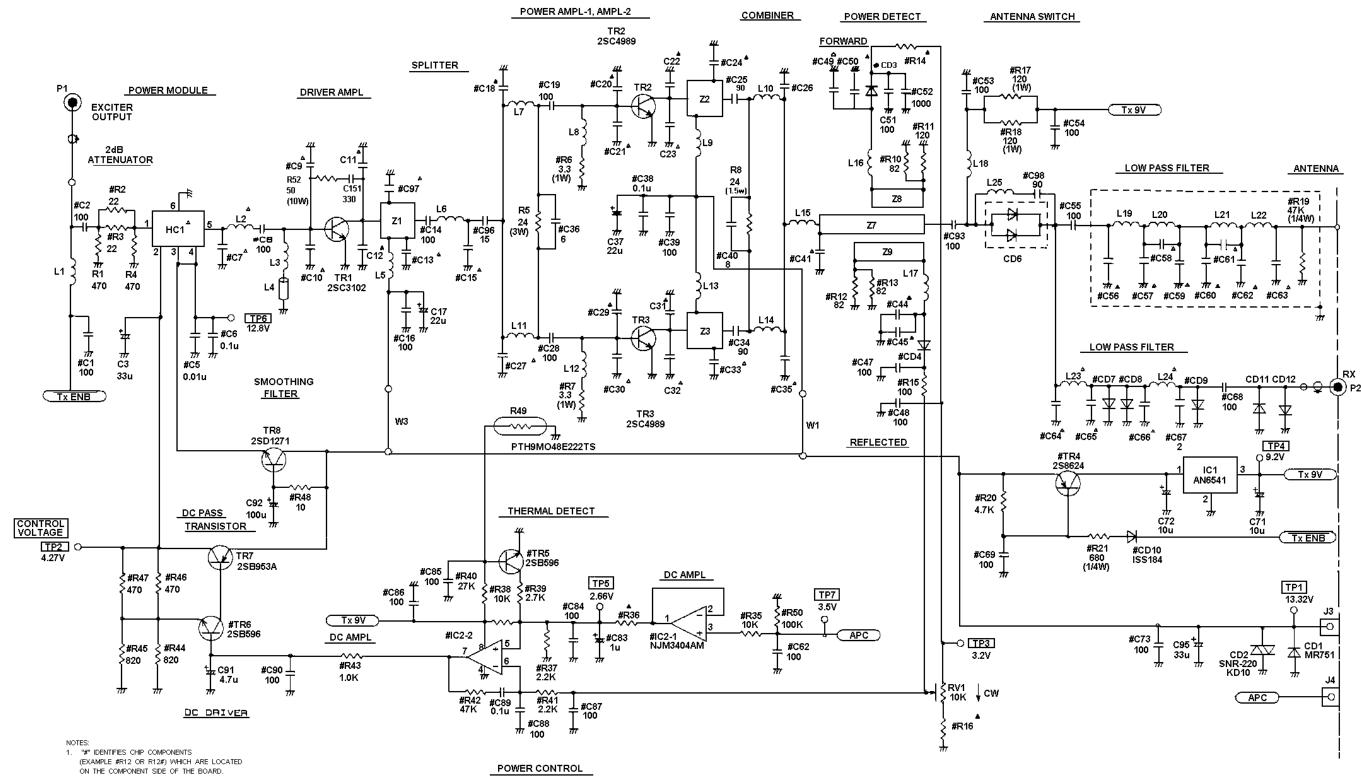
(DD00-CAH-545E)



#### 35/40 Watt Power Amplifier

CAH-545L

(DD00-CAH-545L 1/2)



2. Z1, Z2 AND Z3 ARE STRIPLINE PART OF PWB.

3. RV1 IS FACTORY TUNED AND DOES NOT REQUIRE FURTHER ADJUSTMENT.

ALL RESISTORS ARE 1/10 OR 1/8 WATT UNLESS OTHERWISE SPECIFIED. RESISTOR VALUES IN  $\Omega$  UNLESS FOLLOWED BY MULTIPLIER K OR M. CAPACITOR VALUES IN P UNLESS FOLLOWED BY MULTIPLIER  $\mu$ . INDUCTANCE VALUES IN H UNLESS FOLLOWED BY MULTIPLIER m OR  $\mu$ .

80/100 Watt Power Amplifier

CAH-545H

(DD00-CAH-545H 1/2)